

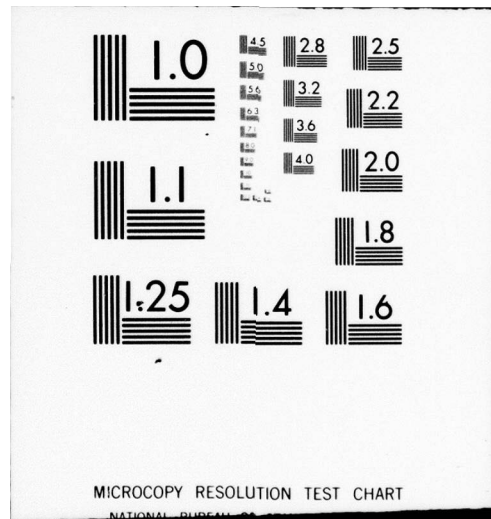
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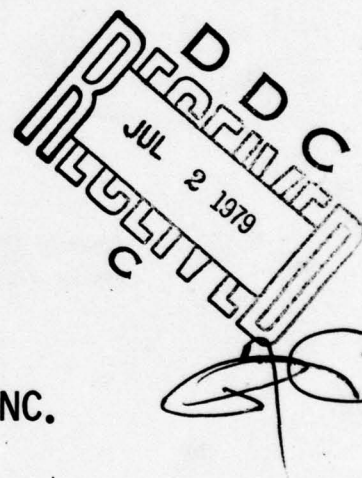
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RESEARCH AND DEVELOPMENT TECHNICAL REPORT
CORADCOM- 77-2727-F-2

TEST PROGRAM SET (TPS) DESIGN GUIDE FOR PLANNING AND
SPECIFICATION OF TPS'S AND ENGINEERING PREPARATION
AND ASSESSMENT OF TPS'S

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| 20. ABSTRACT (Continue on reverse side if necessary and identify by block number) The Test Program Set (TPS) Design Guide provides guidelines and requirements in two major problem areas. It is a planning and specification guide for the competitive procurement of application test program sets for Units Under Test (UUT's) and it also is an engineering guide that provides design and evaluation criteria to ensure acquisition of complete and uniform TPS's. 7(over) | | |

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Topics covered in the design guide include support concepts, data collection, levels of repair, automatic test design considerations, test program set design, interface device design, code and compile, integration, design reviews, and acceptance testing.

Discussed are Automatic Test Equipment (ATE) hardware and software design considerations such as ATE standardization, ATE expandability, and ATE availability which impact total operational life cycle costs. Also covered are required configuration management techniques of identification, control and accounting of test programs.

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TEST PROGRAM SET (TPS) DESIGN GUIDE

FOREWORD

This document prepared for the United States Army Electronics Command, Fort Monmouth, New Jersey, under Contract DAAB07-77-C-2727 is intended to serve as an aid in developing definitive Test Program Sets (TPS's).

The objectives of the design guide are to support specific basic parameters for mission vehicle operational readiness through the development of effective, efficient and economical methods of mechanizing the tools required for supporting and repairing electronic components.

Dynamic Sciences International, Inc. (DSII) has reviewed a significant data base, established by the military and industry, and has arrived at the conclusions contained in this report.

The intent of this study is to identify cost drivers and areas of responsibility that will provide the Army with a basis for TPS development. This development will lend itself towards cost effective measures that will enhance system effectiveness.

SECTION I

1.0 INTRODUCTION

1.1 PURPOSE

This Design Guide has been prepared to provide consistent and uniform requirements and guidelines for planning and specifying Test Program Sets (TPS's) for Units Under Test (UUT's). The Design Guide will also provide both design and evaluation criteria to ensure acquisition of complete and uniform TPS's. Additionally, it covers the prime drivers needed to implement the development of TPS's. Contained in this guide are:

- a. Planning the development of TPS's for the purpose of specifying their total requirements in detail.
- b. Planning the development of TPS's for the purpose of understanding and applying developed information in the preparation of TPS's.
- c. Evaluation of TPS's development planning and implementation during the design and generation of TPS's.
- d. Evaluation assessment of TPS's to ensure acquisition and/or development of complete and uniform products.

If properly implemented, the TPS Design Guide will provide the Army with well planned and well constructed test programs that satisfy the test support requirements at the following Level of Repairs (LOR's):

- a. Organizational

- b. General Support
- c. Depot
- d. Manufacturer (Vendor)

Implementation of the TPS Design Guide has the capability of achieving the following:

- a. Providing a system that when motivated to completion can allow a proper understanding of the tasks to be performed in support of TPS's.
- b. Providing the tools needed to make the SYSTEM work.
- c. Providing concepts applicable to improving the TPS's system requirements.
- d. Describing the effects of implementation of a TPS design guide in terms of capitalization of existing personnel and organizational method of operation.

The foregoing (a. through d.) describe what are considered to be the real drivers in the development of the TPS Design Guide. The contracted elements to be provided will have the capability to assist in:

- a. Planning TPS's
- b. Preparing specifications for TPS's
- c. Providing engineering guides for the preparation of TPS's
- d. Providing engineering guides for the assessment of TPS's

1.2 DESIGN GUIDE PROJECT

The Design Guide Project has been performed in three (3) development phases and is divided into five (5) planning categories of titled structure.

1.2.1 Specific Contractual Requirements

The guide has been developed in compliance with the following contractual terms:

- a. Support concepts, automatic test design considerations, test program set design, interface device design, code and compile, integration and acceptance testing.
- b. Planned and existing ATE have been reviewed. The state-of-the-art in electronic equipment design has been reviewed (in both UUT's and ATE's) and the changing needs for ATE has been projected from the present through five (5) year increments through 1988.
- c. This guide will serve as a simplified reference, for information selection to major support levels for TPS development and application. Topics such as data collection, data analysis, interface design, programming techniques, integration, program verification, fault insertion and acceptance testing, documentation and configuration control will be discussed in the following sections.

Compliance with each of the contract's terms has been met within the body of the guide with easy access and reference to the reader as well as a TPS's development planning user.

1.2.2 The Development Phases

1.2.2.1 Phase 1 - Consists of a thorough research and perusal of all available documentation, including papers, reports, specifications, standards, etc. Phase 1 was not limited to documentation data but also included presentations, meetings and discussions with personnel of varied expertise in the fields of testing, electronics, ATE and TPS development. This included hardware, test software, operating systems, higher order language, on-line edit and compile, and human engineering. The content of these meetings and discussions appears throughout the guide.

1.2.2.2 Phase 2 - Consists of the development of a methodology for absorbing and collating all the data made available and documenting it in a format from which the guide could be systematically generated.

1.2.2.3 Phase 3 - Consists of mechanizing the information and formats established in Phases 1 and 2 into the required TPS Design Guide.

1.2.3 The Planning Categories

The preceding establishes the planning checklist categories of the guide as follows:

1. Support Level
2. Testability/Built-In-Test
3. ATE Factors
4. UUT Data Definition
5. Design Review Requirements

"Configuration Management" is addressed throughout the entire text, and specifically in Section XI.

1.3 ASSUMPTIONS

The foundation of the guide reports is based on the following:

- a. That the guide will be used by engineers and managers who understand the stringent requirements of TPS development.
- b. That only a partial implementation of the guide will be used on certain occasions.

SECTION II

2.0 LEVEL OF REPAIR

2.1 SCOPE

This section deals with the first system level element requiring test definition and/or trade study to determine the proper level at which the Unit Under Test (UUT) should be supported and what diagnostic/isolation criteria may be expected. The product of this section is a checklist which will identify the level of support based on the UUT's ability to be tested and the required or available test equipment.

2.2 GENERAL

Ideally, an electronic system could be designed to diagnose itself through a combination of Built-In-Test hardware and software such that a failure could be isolated to a single sub-assembly at the organizational level. This would require only two (2) organic levels of support, Organizational and Depot. Inherent in this would be the elimination of the general (Intermediate) Support level and the Return-to-Vendor for Repair and thereby eliminate logistic problems these two repair levels cause.

Realistically, this approach exists only on rare occasions. Until electronic systems are truly designed for testability and present untestable systems are purged from the inventory, actions must take place that will allow the best technical and cost related decisions possible within our present and near term projected test environment.

Checks and balances of where and how to test and support electronic systems is dependent on a myriad of complex technical and cost factors.

The following discussion is provided to give insight into those factors which allow a procurement agency to specify the proper level of support and test isolation criteria for a given electronic system and its sub-assemblies.

Discussions in this section assume that (a) some testability design requirements were imposed on the supplier during procurement, and (b) that some form of Logistic Support Analysis (LSA) has been performed to determine a preliminary support/test level. In the event either or neither were accomplished, this section provides insight into a stand-alone determination of the level of repair assignment along with a brief accessment of the testability of the UUT that should be required.

2.3 REFERENCE DOCUMENTS

The following documents were utilized as reference material - pertinent to this section.

Military:

- MIL-STD-1388 - Logistic Support Analysis
- MIL-STD-415D - Test Provisions for Electronic Systems and Associated Equipment, Design Criteria for
- MIL-STD-1326 - Test Points, Test Point Selection and Interface Requirements for Equipments monitored by Shipboard On-Line Automatic Test Equipment
- NAV MAT INST 3960.9 - Built-In-Test (BIT) Design Guide
Enclosure III dated 9 September 1978

Other Publications:

ARINC Pub. 562-01-1-866 - Guide to the Application
of Built-In-Test

2.4 LEVEL OF REPAIR/TESTABILITY CONCEPT

A summary checklist of the major Logistic and Testability factors that determine the UUT Level of Repair are provided. This is accomplished by summarizing the Logistic Support Analysis data and combining this with an assessment of the UUT's testability.

2.4.1 General

For the purposes of this discussion, the following support levels are defined along with their generally accepted functional goals and/or responsibilities:

- o Organizational - On-board test to isolate a failure to a single faulty Line Replaceable Unit (LRU). Remove and replace the LRU and retest system to verify proper operation.
- o General/Intermediate - Diagnostic test of the LRU to isolate to a faulty Shop Replaceable Unit (SRU). Remove and replace the SRU and retest the LRU to verify proper operation.
- o Depot - Diagnostic test of the SRU to isolate to the faulty component(s). Remove and replace components and retest the SRU to verify proper operation.

Concurrent with the above, other support requirements that directly affect

and influence Maintainability and Reliability characteristics of electronic design and are major inputs to the LOR are:

- o Number of sites anticipated
- o Number of operating hours of the MISSION VEHICLE
- o Number of MISSION VEHICLES to be activated
- o Skill levels required at each echelon
- o Quality and availability of component parts

Decisions based upon the results of the LOR and LSA programs, for any given piece of electronic hardware, directly affect the maintenance concept, spares provisioning, level of training, depth of coverage in technical manuals and support equipment recommendations.

Based on an analysis of available data, it was determined that regardless of the care taken in the preparation of a detailed Logistic Support Analysis (LSA), a UUT is often assigned to a support level which is either incompatible, inefficient or totally unnecessary.

In the latter part of this section, each level of repair is discussed in detail as it applies to testing of electronic equipment.

2.5 RELIABILITY AND MAINTAINABILITY

In order to properly assess the implications of this guide to TPS development, a cursory description of Reliability (R) and Maintainability (M) practices is provided.

2.5.1 Reliability (R)

Reliability is an important characteristic of military electronic equipment, and all factors affecting reliability are carefully evaluated in trade-off analyses beginning in the early design phases and continuing through the manufacturing phases. Primary requirements should be set to assure the achievement of the required reliability levels, for any specified equipment(s), in the most cost effective manner possible. A Reliability Program should be instituted for the positive control of parts and materials, reliability test and evaluation, and the analysis and correction of failures and design deficiencies.

2.5.2 Maintainability (M)

The prime purpose of any Maintainability Program is to describe the management controls and procedures that will be followed by the contractor and any subcontractor to ensure the highest possible degree of maintainability, consistent with operational requirements and support capabilities.

The major task of influencing design regarding M requirements is accomplished by the establishment of a direct line of communication to the cognizant design engineer. The M engineer should maintain continuous design liaison so that an analysis of the various design alternatives is conducted. In this manner, requirements, assessments and guidance can be provided in areas where M is affected.

Because of the interaction and trade-off potentials between Reliability and Maintainability, close coordination between the two functions must exist. The Reliability activities provide progressively detailed future prediction rates based on design progress and baseline changes. This data

will be used by Maintainability for determination of M parameters. Similarly, Maintainability will keep the Reliability group informed of all significant changes in quantitative values, based on these M predictions, such that appropriate trade-offs and corrective actions can be initiated.

A properly constructed M program addresses itself additionally to factors other than inherent design reliability and configuration. The factors that should be included and outlined in an equipment specification are:

- o Interchangeability requirements.
- o Provisions for Built-In-Test (BIT) features, construction and packaging, provisions for test points, and other Maintainability parameters as specified in military specifications.
- o Equipment compatibility with anticipated Automatic Test Equipment.
- o Built-In-Test used to isolate any SRU to within a specified confidence factor with a prescribed Turn-Around-Time.

2.6 MISSION VEHICLE AVAILABILITY

Mission essentiality is the prime requirement in any military scenario. Mission essential equipment is specified for the various types of Mission Vehicle applications. In many instances, specific missions may be

conducted with limited or partially working systems. However, the ultimate desirability is that all systems be operable. Factors influencing Mission Vehicle availability are:

- o Reliability of the system or its sub-systems.
- o Maintainability wherein faulty elements or elements of a system are rapidly isolated and replaced.
- o The ability to readily remove and replace the faulty element(s) of a given fault isolation group with a functional element as rapidly as possible, AND Packaging for functional modularity plus appropriate test points to determine the size of the fault isolation group.
- o Logistic Spares available at the appropriate maintenance level, and that any movement between maintenance levels be conducted expeditiously.

The military measure of determining availability of a deployed system is expressed as Mean-Time-Between-Failure (MTBF) and Mean-Time-To-Repair (MTTR) in the following equation:

$$\text{Availability} = \frac{\text{MTBF}}{\text{MTBF} + \text{MTTR}}$$

MTBF is the Mean Time Between Failures

MTTR is the Mean Time To Repair

Although there is a general belief that each of these factors, (i.e., MTBF/MTTR), are definitive in theory, they are not as clearly defined in practice. Determining exactly when an equipment has failed is difficult to determine. This is particularly true where today's systems have been redundantly designed or have the capacity to operate in a degraded mode.

A brief dissertation on how MTBF and MTTR affect this design guide follows:

2.6.1 Mean Time Between Failure (MTBF)

Micro-electronic technology has advanced wherein the cost, weight and power of a given system function has declined, systems have become more and more complex. Because the number of active elements for a given system has increased dramatically, MTBF's have tended to become lower, even with improvements in device reliability.

Various techniques including redundancy are widely used to improve the situation. Predicated on our analysis, one must accept that with highly complex systems, the effect of MTBF on availability is statistically limiting and that improvements to MTTR, as outlined below, usually provide the most cost effective solutions to availability problems.

2.6.2 Mean Time To Repair (MTTR)

MTTR is a very complex function and to develop the techniques necessary to improve it, the effects of the various elements must be identified and understood so that the proper life cycle cost analysis can be made for each maintenance level, MTTR may be generally described as follows:

$$MTTR = K_1 t_D + K_2 t_I + K_3 t_{RR} + K_4 t_C$$

where $K_1 t_D$ is the time taken to detect a malfunction of the electronic unit.

$K_2 t_I$ is the time taken to isolate a failure to a fault isolation group.

$K_3 t_{RR}$ is the time taken to remove and replace the faulty elements.

$K_4 t_C$ is the time taken to confirm that the repair action was successful.

o $K_1 t_D$ Time Taken to Detect Failure

Essential where safety or mission success requires a need to know rapidly that an equipment is malfunctioning. This element then may be the only driving factor.

Equipments of this type still have to be maintained, and it should not be allowed that the primary requirement exclude other testability requirements.

o $K_2 t_I$ Time Taken to Isolate a Failure

The time taken to isolate to a specific fault isolation group is a direct function of the testability design of the UUT or the extent to which BIT has been incorporated.

o $K_3 t_{RR}$ Time Taken to Remove and Replace Faulty Element

Ideally, a malfunction will result in the identification of a fault isolation group of a single element of a major assembly. Without an adequate design for testability, this may not occur. It can be readily appreciated that adequate fault isolation will reduce the number of assemblies to be spared, and the time taken to replace a single element will be less than for a group.

The major requirement is that the equipment should be designed for ease of removal and replacement of all identifiable (by the fault isolation group) sub-assemblies.

o $K_4 t_C$ Time Taken to Confirm that the Maintenance Action was Successful

This element is important at all maintenance levels, but particularly where the unit under test has been transferred from one maintenance level to another. It is not unusual for test tolerance, and certainly test thoroughness, to be less at the organizational level than at other levels of maintenance, particularly where sub-assemblies may need calibration or adjustment.

2.6.3 Built-In-Test (BIT)

Before determining how to evaluate and/or implement BIT, it is necessary to determine the type of testability that is necessary and readily provided for a particular type of equipment at all maintenance levels. Proper implementation of BIT at the Organizational (O) level is just as dependent on testability as are test techniques using ATE or test equipments at the general support and depot levels.

Maintenance testing at the organizational level should be accomplished by use of BIT techniques supplemented where necessary by contact type testers and should be a goal to provide maintenance test using BIT only.

The term BIT has been used in context to clarify a group of techniques that are used for testing equipments at the organizational level. In developing checklists for testability, these techniques will be considered as part of an overall testability requirement.

From a cost standpoint, it is highly desirable that the fault isolation group is a unity which requires a minimum quantity of spares. However, if the time taken to isolate to a small ambiguity group is excessive or the additional BIT hardware overhead exceeds an economic or reliability level, it may be appropriate to accept a higher fault isolation group.

In the past, a major objection to the incorporation of adequate BIT hardware was cost, both in terms of additional design cost and recurring item cost. Recent studies have shown that the cost of adding BIT techniques has been relatively modest in comparison to the life cycle sparing and maintenance cost saving, as identified below:

2.6.4 'BIT' Quality

If $MTTR = K_1 t_D + K_2 t_1 + K_3 t_{RR} + K_4 t_C$, then the testability at organizational level could be described as $K_1 t_D + K_2 t_1 = \text{BIT Quality}$.

K_1 is a complex factor which is a function of the Military Essentiality Code MIL-STD 1388-2, the type of equipment and the type of technology employed. Presently, BIT is often driven purely by the Military Essentiality Code. For instance, in an aircraft the primary driver for BIT will be the fact that flight safety has to be maintained and a malfunction of an equipment essential to personnel safety has to be quickly recognized. Whereas, in many cases, equipment failure may only partially impair the ability of a weapon system to function, for instance, a defective channel in a multi-channel communication system.

The benefits expected to be realized by the addition of BIT are:

- o Reduced maintenance skill levels
- o Reduced maintenance man-hours
- o Reduced MTTR
- o Improved availability
- o Reduced level of O-level test equipment
- o Reduced maintenance life cycle cost

Penalties that might be expected are:

- o Increase in acquisition cost
- o Decrease in MTBF

- o Increase in weight, power requirement and heat dissipation
- o Increase in sub-assembly spares at organizational level
- o Increase in cannibalization at organizational level

Depending on the type of equipment and its intended environment, all of the above factors have to be taken into account.

BIT should be looked upon as a primary part of testability. The extent to which BIT is implemented must be determined by the cost of incorporation compared to the improved availability and the reduction of life cycle maintenance costs. If equipment is designed to be testable, the cost of BIT and maintenance will be reduced.

2.6.5 Personnel/Management

The technical skills required to accomplish electronic system maintenance are defined in the following manuals:

AR611-1-1 - Manual of Commissioned Officer
Military Occupational Specialties

AR611-112 - Manual of Warrant Officer
Military Occupational Specialties

AR611-201 - Enlisted Military Occupational Specialties

The classifications and specialties defined therein provide for adequate skill level definition and commensurate qualifications and initial training.

Some areas of personnel and shop management that should be considered are:

2.6.6 Training

Specialized training is required to effect total system definitization. An operation of this type requires that the test operator not only be familiar with mature functional test setup, but provides him with the capability to analyze a faulty test setup.

Lack of this type of training diminishes the value of test programming by extending the test time and too frequently rely on a random method to affect a repair.

Random substitution causes good units to erroneously enter the repair cycle and expends spares inventory at an excessive rate, thereby increasing spares requirements.

General and Depot support levels should employ either continuous or frequent training courses to provide and maintain highly skilled troubleshooting technicians.

2.6.7 Cannibalization

A major identifiable problem with support below the Organizational level is the cannibalization of one unit to repair another.

Most test programs, particularly those developed for use on Automatic Test Equipment, are written to detect a single failure. If the test unit comes to the General Support, Depot or Vendor with multiple failures induced by substitution through cannibalization, the test time required to affect repair is significantly increased.

Cannibalization is generally not "allowed," therefore, no records of the substitution activity or any description of the failure symptoms can be quantified.

An instance might be, at the Organizational level, the crew of an operational weapon system will do all in its power to achieve a high percentage of mission availability. This includes cannibalization and other normally authorized work-arounds which contribute to problems at the other support levels including:

- o Cannibalization - resulting in multiple unit failures and configuration anomalies.
- o Unauthorized repairs - resulting in damaged hardware and configuration anomalies.
- o Improper failure reporting - resulting in additional test time to identify failures.

These problems can be controlled by sound management at the organizational level through training, quality assurance provisions and incentives for following the rules.

2.6.8 Spares

The LSA identified system requirements by maintenance level and frequency of use, for spares, repair parts, and consumables. Impacts upon storage spaces, supply facilities, equipment, personnel, and procedures are evaluated for each support system approach under consideration. Supply data resulting from the LSA include spares and repair parts provisioning; consumption and usage rates; recommended allowances; supply storage requirements; and Source, Maintenance and Recoverability coding.

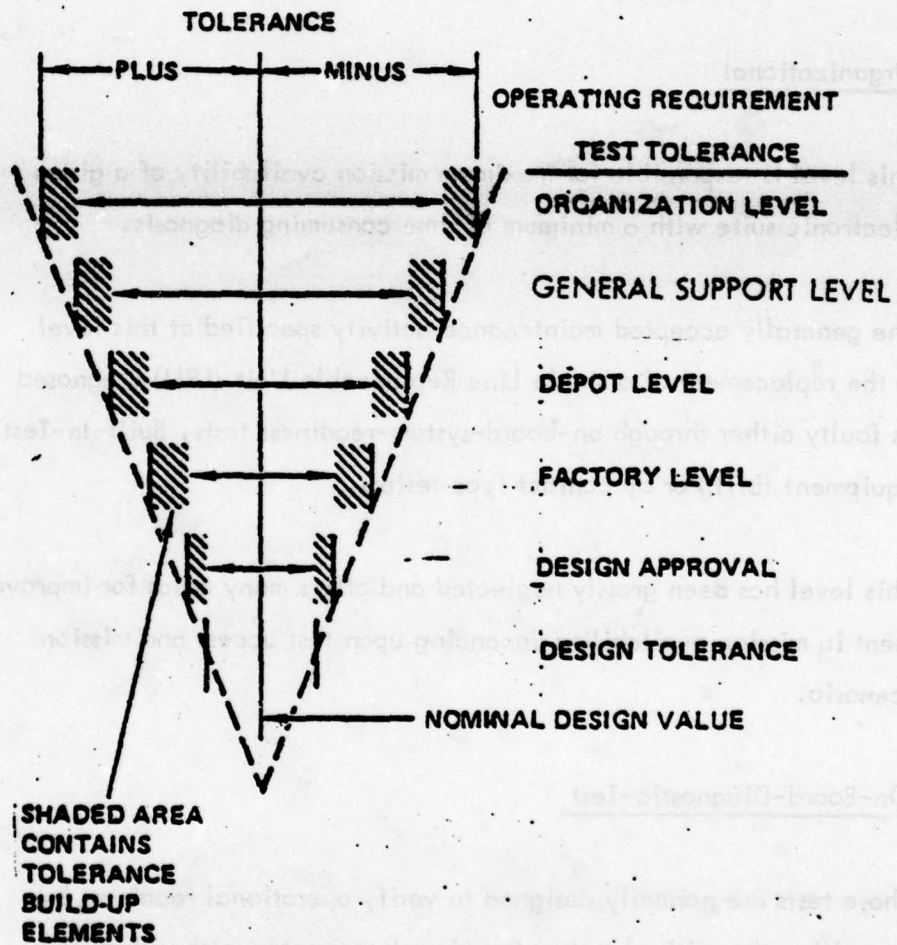
The military spares provisioning system is complex and costly to establish and maintain and is very susceptible to problems if improper maintenance activities are practiced. (Re: NASC; NAFI documentation)

There exists, therefore, a proper management of spares inventory in support of the automatic test and repair activity that becomes a major factor contributing to a maintenance program's success.

2.7 TEST TOLERANCE

The preceding sections have delved into the philosophy of TPS testing, however, the main driving factor is testability and test tolerances as discussed below:

- o It is imperative that test tolerances are organized so that test requirement definitions are correlative at the different support levels.
- o Figure 2-1 illustrates a classical tolerance cone that defines the test tolerance build-up from basic design tolerance through the various support levels to the operating environment.
- o The test tolerance element becomes most critical at the General Support and Depot Maintenance levels where very complex systems using ATE may attribute to long test times. Exemplary design for testability and BIT hardware can be used to reduce the Mean



TOLERANCE CONE

FIGURE 2.1

Time to Repair (MTTR) at these support levels and consequently reduce the quantity of spares and ATE required at the test site.

2.8 IDENTIFIABLE LEVELS OF REPAIR

2.8.1 Organizational

This level is responsible for maximum mission availability of a given electronic suite with a minimum of time consuming diagnosis.

The generally accepted maintenance activity specified at this level is the replacement of a single Line Replaceable Unit (LRU) diagnosed as faulty either through on-board-system-readiness tests, Built-In-Test Equipment (BITE) or by contact type testers.

This level has been grossly neglected and offers many areas for improvement in mission availability depending upon test access and mission scenario.

2.8.1.1 On-Board-Diagnostic-Test

These tests are normally designed to verify operational readiness by exercising the critical system functional parameters either through the Built-In-Test-Equipment (BITE) or a software program exercised through a central computer or a combination of both.

Failure indications may be displayed on individual LRU BITE indicators or on a visual display, printer or storage medium, i.e., magnetic tape, tied to the central computer diagnostic program.

A detailed review of the on-board-diagnostic-test capability will invariably result in the conclusion that improvements can be made in both diagnostic isolation and failure message reporting.

Diagnostic isolation can typically be improved to reduce failure ambiguities and to extend the diagnostic isolation on critical parameters to a lower level of replacement. Reducing failure ambiguities means that only the faulty unit must be removed and replaced, and the good unit is not jeopardized by unnecessary removal, handling and replacement. This procedure also allows for a minimum spares inventory.

Extending the diagnostic isolation capability allows for the repair of the faulty unit at the organizational unit by replacing faulty sub-assemblies. This decreases higher level unit spare inventory and reduces unit testing at the next maintenance level.

Failure message reporting is a valuable asset and can typically be expanded to include troubleshooting information that will assist in pinpointing an otherwise ambiguous failure. The result is much the same as improving the actual diagnostic software and results in fewer spares and less handling of functional units, thereby reducing costs.

2.8.1.2 Contact Test Equipment

In the event operational readiness cannot be verified through the on-board-system-readiness test, portable contact type test equipment is required to complete the readiness verification. This contact type equipment can range from a simple oscilloscope, signal generator or meter to a complex piece of special purpose diagnostic test equipment.

The decision to use this equipment or specify new equipments to augment the operational readiness test depends on several factors.

- o Operational safety or mission criticality (Primary)
- o Reliability (Secondary)
- o Contact Equipment Diagnostic Capability (Secondary)
- o Contact Equipment Test Time (Secondary)

The trade-offs required to determine whether contact test equipment should be used in lieu of test at the General Support level have been outlined in the checklist.

2.8.1.3 Performance Monitor/Test

Idealistically, all electronic systems would employ an operational performance monitoring system which would provide the operator with an evaluation of the system performance or any malfunction during the operating mission.

Since the services have procured, at great expense, a multitude of test systems, it is very probable that an existing Performance Monitor/Test system can be improved or modified that will provide sufficient information to allow for repair at the organizational level. This precludes the need for an additional test at the General Support level.

2.8.1.4 Failure Reporting

Organizational level tests are only valuable if they display and/or record the evaluation data in proper form. Wherever possible, troubleshooting information should be included with the failure message. This, of course, is not possible when the BITE flag is the only indication of failure. However, when BITE is controlled by a central computer, it is quite possible that additional diagnostic data can be made available for display or recording that would greatly assist the technician in isolating the failure.

A detailed review of the operational readiness software should be made to determine cost effective improvements in failure message reporting.

2.8.1.5 Organizational Support Summary

Those major factors which affect Test Program Set Design have been presented in narrative to assist in the general decision making process to determine the need, cost effectiveness and technical requirements for Test Program Sets at the Organizational Support Level.

The checklist in Figure 2.2 will address those organizational support level questions affecting test program set development.

2.8.2 General Support Level

The first support level where off-line test and repair of faulty electronics is conducted - the shop is typically, but not necessarily, located at an operational facility and provides "batch-test-processing" of electronic units identified as faulty at the Organizational Level (i.e., replacement of a faulty LRU by BIT/BITE analysis).

The General Support facility normally provides test and repair facilities for Line Replaceable Units (LRU's) involving removal and replacement of Shop Replaceable Units (SRU's) and LRU retest and return to Organizational Level for spares stock.

Due to the normal proximity of the General Support to the Organizational Level, it is common to depend on very short term turnaround repairs of faulty units. Normalized general support and organizational supply facilities are located at the same site.

Any trade-off that can reduce test complexity and test time that can be effectively accomplished at the Organizational Level should be done there. Effective on-board-diagnostic-isolation testing will save countless hours and dollars at the General Support Level.

It is not uncommon for the General Support Level to provide Shop Replaceable Assembly (SRU) repair service. This makes the on-board performance test even more critical since SRU testing is much simpler and faster than LRU testing and would merely require a functional retest of the LRU after SRU repair.

Because of the diverse test requirements of this support level, the test equipment, adapters and software programs are quite numerous, costly and complex. Anything that can be done to effectively reduce the quantity and complexity at the General Support Level efforts should be considered.

The decision whether to repair a faulty unit at the General Support Level is discussed in this section.

2.8.2.1 Test Equipment

The General Support facility should contain a large variety of test equipment ranging from simple manual instruments through complex peculiar and general purpose automatic test systems.

Maximum use should be made of the general purpose ATE to minimize manual operations and allow for consistency in test program format and test language.

2.8.2.2 LRU/SRU Test

Most modern electronic system LRU's can and should be tested using a General Purpose Automatic Test System. The present exceptions to this are some RF systems either requiring extreme frequency and/or power stimulus/measurement or extremely high speed digital systems requiring dynamic test. Other exceptions are those LRU's that have very limited test access or ATE incompatibilities.

These exceptions are typically supported by Peculiar Ground Support Equipment (PGSE) furnished at the organic support facility by the

electronic supplier or returned to the suppliers facility for repair or replacement.

LRU diagnostic test programs are costly and complex to develop and maintain. Every means to minimize the complexity and maximize the test effectiveness must be considered.

The questions to consider in determining LRU test at the General Support level are contained in the checklist Figure 2.2.

The decision of WHERE, WHEN, HOW and/or IF to test and repair a SRA involves a myriad of complex trade-off factors. One might be that it is neither economically feasible or necessary to test all SRA's in an electronic system. When the decision is made for test and repair, that responsibility is typically assigned to the Depot level or the SRA is returned to the electronic equipment supplier for repair or replacement. In many instances, it may possibly be more effective to repair some SRA's at the General Support Level depending on the Depot work load and/or the organizational support requirements.

2.8.2.3 Failure Reporting

Regardless of the equipment used for test and repair, it is mandatory that complete and accurate descriptions of failures be recorded. Where UUT failure messages contain ambiguous callouts, it is required that either the failures be prioritized as to most likely or that troubleshooting information be provided to assist the technician in his repair.

2.8.2.4 General Support Summary

The primary responsibility of the General Support Level is to provide rapid test and repair of LRU's and return them to the Organizational Level for use as spares.

The most efficient method of achieving this is through the use of ATE.

Also, it is extremely important cannibalization be minimized at the Organizational Level in order to effectively accomplish rapid test and repair at this level. Any cannibalization must be reported in detail in order that real failures are enumerated to provide accurate maintenance records.

2.8.3 Depot Level

Depot Level is the last opportunity to effect a test and repair of electronic equipment. For the purpose of this discussion, consider the electronic equipment supplier as an extension of the military depot. This premise is made because the supplier may be the only source of proprietary components and/or may possess the only and/or most efficient means of test and repair.

The major problem with Depot or Supplier support is the time required to effect a repair. This, of course, dictates that the spare inventory at both the General Support and Organizational levels be adequate to allow for Depot replacement in order to achieve a reasonable operational mission availability.

It is extremely important that the diagnostic testing done at the General

and Organizational levels results in accurate failure isolation so that "good" units are not cycled through the Depot pipeline.

Depot activities typically include the test and repair of LRU chassis backplanes or wiring, SRU's on ATE and LRU's and SRU's requiring Peculiar Ground Support Equipment (PGSE).

The factors to consider in making the decision if and where to test and repair are outlined in the checklist Figure 2.2.

2.8.3.1 ATE

At the General Support level, ATE should be used for test and repair as much as possible to minimize test time and maximize test program compatibilities.

Ideally, the same ATE will be available at both the General Support and Depot levels so that the test strategies will be directly complimentary and in the same test language.

2.8.3.2 Peculiar Ground Support Equipment (PGSE)

When PGSE is required due to special test requirements, it is highly desirable that the test language be as similar to the general purpose ATE language as possible. This allows for minimal special training of test personnel and provides a thread of continuity in the TPS format.

2.8.3.3 LRU/SRU Test

The majority of test activity at Depot should be SRU test and repair. However, some LRU test and repair will undoubtedly be required, either

due to General Support level work load or, that LRU test programs do not test LRU chassis or backplane wiring.

In the case of General Support level overload, it is recommended that any LRU test be done at Depot on the same ATE as at General Support. In the case of LRU chassis test, it is suggested that an automatic continuity tester such as DITMCO, FACT or DIGITRACE be used and not done on ATE.

2.8.3.4 Vendor Support

Test and repair at the vendors facility of some UUT's will always be required, particularly for those SRA's that have a high MTBF but at a cost that prohibits a throw-away classification.

When possible, vendor support requirements should be specifically defined to specify a maximum turnaround time so that the General Support level spares requirements can accurately be determined.

It is not technically required that the vendor support his repair activity with ATE, but it is desirable from a cost and schedule standpoint. As a minimum, the vendor test must be compatible with the military depot maintenance philosophy to assure continuity in the maintenance support chain.

2.8.3.5 Depot Summary

Time is the essential element in the success of the depot support level. Proper utilization of a mix of manual, automatic and peculiar testers such that test backlogs are minimized is extremely important.

Piece part spares should be overstocked. It is not mission effective to have a system or vehicle unavailable for its mission for lack of a ten-cent component.

2.9 LEVEL OF REPAIR CHECKLIST

Level of Repair studies and decisions are a subset of the maintenance concept plan, which itself is a part of Integrated Logistic Plan. The maintenance concept determines the maintainability in design requirements to be imposed on the hardware engineers. It takes into account the operational requirements of the weapon systems and the skill levels required at each level of maintenance. The level of repair decisions are used by the logistic support planners to determine spares, training and maintenance facility requirements.

The goal of a Level of Repair Analysis is to assure required operational availability of a system considering all life cycle costs.

The purpose of this checklist is to assist the procuring agency in determining the optimum level of automatic test and repair support for military electronic systems.

This checklist assumes that some sort of Logistic Support Analysis (LSA), in accordance with MIL-STD-1388-1/2, has been accomplished.

Use of the checklist will, therefore, either confirm the results of the LSA or suggest alternative test support options.

2.9.1 Support Level

Data required in each of the support level sections is available from the LSA conducted in accordance with MIL-STD-1388. If no LSA was accomplished, UUT analysis should be conducted to assure that the minimum data is available.

a. Organizational

Automatic Test defines the method, if any, by which a failure is detected automatically on-board.

Contact Test Defines the method, if any, by which a failure is detected through the use of portable, plug-in type equipment.

Failure Data Reporting should be in a format that when a failure is reported for both functional and diagnostic test, it provides the next support level with sufficient data to consistently duplicate the indicated failure.

Diagnostic Isolation provides for a percentage estimate of all testing done at the organizational level. For an LRU within a subsystem, "Does the automatic and/or contact test equipment isolate to a single LRU 100% of the time?" Or, if isolation is attempted to the SRU level, "What percentage of SRU's are unambiguously detected?"

The quantity of available spares should be such that those failures that are detected at the organizational level can be replaced by functional units from stock.

Cannibalization should be strictly prohibited.

b) General Support

The level of repair at the General level of maintenance will include the subsystem, LRU, SRU or actual test equipment maintenance and repair. To satisfy the non-ambiguity requirements of the testability specification, the electronic design must be functionally partitioned to allow for a specified degree of unambiguous isolation. Failure tolerances, both for functional failures and degraded performance isolation, will be somewhat more stringent than that at the Operational level. All cases of failure at the operational or test connector interfaces shall be detectable. It shall be a general requirement that all LRU's be capable of testing at the General Level of maintenance without the need for stimulation by another WRA or special test device.

When performing LRU fault isolation, the minimum acceptable requirement for non-ambiguous SRU isolation is as follows:

- 1) In at least 90% of the cases of probable malfunction of an SRU, the fault shall be isolated to a specific SRU.
- 2) In 95%, or more, of the cases of probable malfunctions of an SRU, the fault shall be isolated to that SRU and no more than one other SRU.

- 3) In all cases of probable malfunction of an SRU, the fault shall be isolated to that SRU and no more than two other SRU's.

To demonstrate the acceptability of the equipment and test program to satisfy the desired non-ambiguity requirements, a calculation of a figure-of-merit (i.e., pass/fail criteria) will be determined in accordance with the formula

$$FOM = \frac{\text{Failure Messages Containing (N) or less SRU's}}{\text{Total Failure Messages}} \times 100$$

where $1 \leq N \leq 3$

A similar formula will be utilized for component isolation of a particular SRU, where the diagnostics will un-ambiguously fault isolate to

- 1) 3 or less components for 80% of the possible faults, and
- 2) 5 or less components for 90% of the possible faults, and
- 3) 8 or less components for 100% of the possible faults.

Failures due to power, clock and single source bussed signals will not be included within the non-ambiguity calculations.

A thorough analysis of the test program is required to establish the expected non-ambiguity values in the field environment. The method of calculation, using a diagnostic message count

as the criteria for the FOM, may be the most reasonable approach. However, the results can be effected or biased by:

- 1) Unnecessary repetitious and redundant testing.
- 2) Non-comprehensive functional testing (i.e., missing tests).
- 3) Combinational and iterative testing of logic circuits in all possible bit patterns.
- 4) Programming structure (i.e., independent tests versus combinational tests to achieve same results).
- 5) Intentional or unintentional use of excessive probing tests.

The full intention of a figure-of-merit is to provide a level of confidence in the test design and test program to provide for a high degree of readiness.

Spares allocation will be a function of the maintainability analysis, FMEA and the percentage of real isolation messages attributed to the particular module. Spares availability should be such that the MTTR can be met. A similar spares provisioning, for piece part components, should be established for proper support of SRU repair.

c) Depot/Supplier

Depending on the weapon system to be supported, the General Level of Repair may be adequate to resolve most repair problems. However, there is sufficient complication in electronic devices, such as electro-mechanical and electro-optical devices that a special Depot level of repair may be warranted. Such devices requiring stabilized platforms, antenna tests, RF testing and the like are not normally repairable at the General Level.

Special calibration procedures and equipment, in conjunction with tailored Automatic Test Equipment, would be required to duplicate factory test and repair procedures. The definition of these special test requirements must be specified early in the procurement phase and approved by the procuring activity.

Automatic and special test equipment must rely heavily on comprehensive self-test features in order to minimize the proliferation of added test equipment. Every attempt should be made to eliminate the need for calibration standards and special alignment fixtures.

On occasion, it may be necessary to return the unit to the manufacturer for single unit repair and adjustment. However, it should be the policy of the Army that a stand-alone maintenance capability be resident within the various levels of repair with minimum dependency upon vendor or manufacturer support.

This self-contained maintenance capability may not be obtainable, however, until some time after deployment.

A specific plan for phasing out the vendor must be an integral part of the support plan as well as the Configuration Control Plan.

LEVEL OF REPAIR CHECKLIST

SECTION III

3.0 THE TPS DESIGN GUIDE

3.1 GENERAL DESCRIPTION

The TPS Design Guide is described in a general sense by Figure 3.2. The purpose in describing the guide in block diagram format rather than a stacked "table of contents" form is:

It more readily demonstrates the "serial" flow of task elements that must be performed to develop the TPS.

It shows the time sequencing of the task elements and to a great degree their interrelationship. In essence, a sort of functional/time PERT chart including pacing items and looping requirements.

It presents the "total" picture of task elements to be considered, understood and applied in the development of TPS's. It shows where to start, how to proceed, what must be done, and when to perform each task element.

The TPS development effort can be expressed in a very simple form. Figure 3.1 attempts to show that simplified form, but there are a number of tasks that make up each of the simplified blocks. These tasks are shown in Figure 3.2. Because of the many tasks that are necessary to complete the development effort, the simple block diagram is shown with cross references to the detailed block diagram.

This will allow the guide user to see the overall development effort at a glance and the detailed steps in that effort if desired.

Figure 3.2 does not describe the results of functional non-compliance with the task elements, or the effects of only partial compliance. Some of the resultant perturbations are self-evident, and the text of the guide will define to the guide user other potential detriments to the engineering system that can result from an ill-accomplished task element.

The projected purpose of Figure 3.2 in its presented format is to provide the user with a visual tool that not only describes but tracks his functions in the TPS development chain regardless of the size of his portion or his requirements of applications.

3.2 SYSTEM FORMATTING

Figure 3.2 sequentially formats the engineering system presented in the guide. Each of these components will be discussed as to their content and place in the total picture of TPS's development, starting with the Mission Vehicle (be it an electronic system, an LRU, an SRU or an SSRU), and completing with the parameters of TPS's acceptance by the paying user.

3.3 MISSION VEHICLE

3.3.1 General

The initiation of any type TPS development task generally starts at a point this guide considers "partway down-the-line." In order to organize proper TPS development, the management and engineering systems groups performing their assignments must be provided with, and exposed to, the entire real

and potential problem matrices that can be demanded by the Mission Vehicle in all modes of its operational readiness functions. Therefore, the guide's content will be "started" at a "beginning" point that forces the required Unit Under Test (UUT) understanding capabilities.

3.3.2 Unit Under Test (UUT)

The UUT in the guide is named the Mission Vehicle because it not only performs an intended task, but is also designed to accomplish a MISSION of some type, in some manner and to some degree.

This UUT can be a system, a Line Repairable Unit (LRU) which can be part of a system; a Shop Repairable Unit (SRU) which is part of an LRU; or a Sub-Shop Repairable Unit (SSRU) which is part of an SRU. The first function of the guide is to systematically provide the necessary information for understanding the UUT.

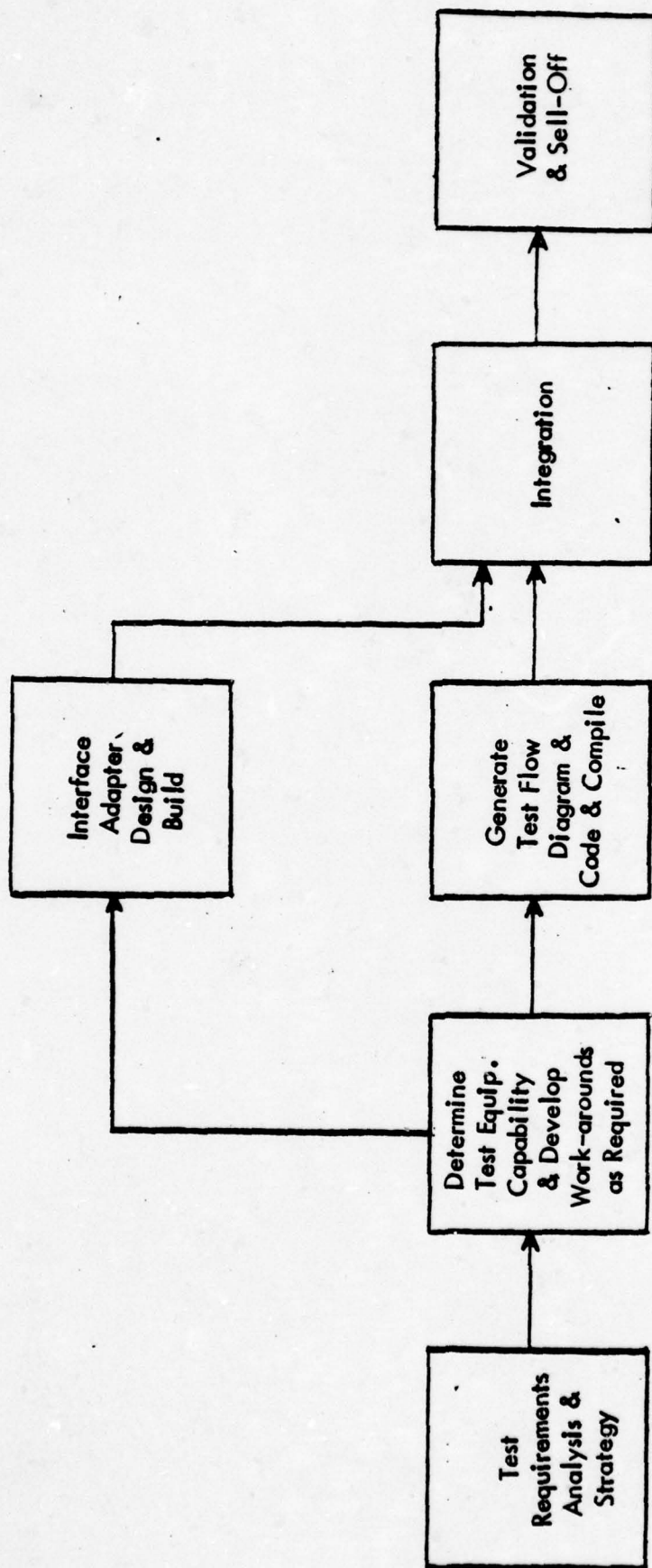
3.3.3 UUT Definition

The UUT is first defined in terms of what type of component it is from an applications standpoint, both functional and operational. The purpose of the UUT definition is primarily to indoctrinate management and engineering to all functional and operational aspects of the UUT, to blaze a trail to the location and procurement of the necessary data and information on the UUT, and to become acquainted with the personnel and organizations presently and potentially to be involved. In addition, the guide users are how prepared to understand and apply the UUT's functions of performance, design, support and configuration control. In reality, the guide's first checklist of user evaluation function is developing. A complete checklist covering UUT definition, which should be applicable to all

UUT's after considering "what" needed additions and/or deletions should be made as a result of the UUT's own peculiarities.

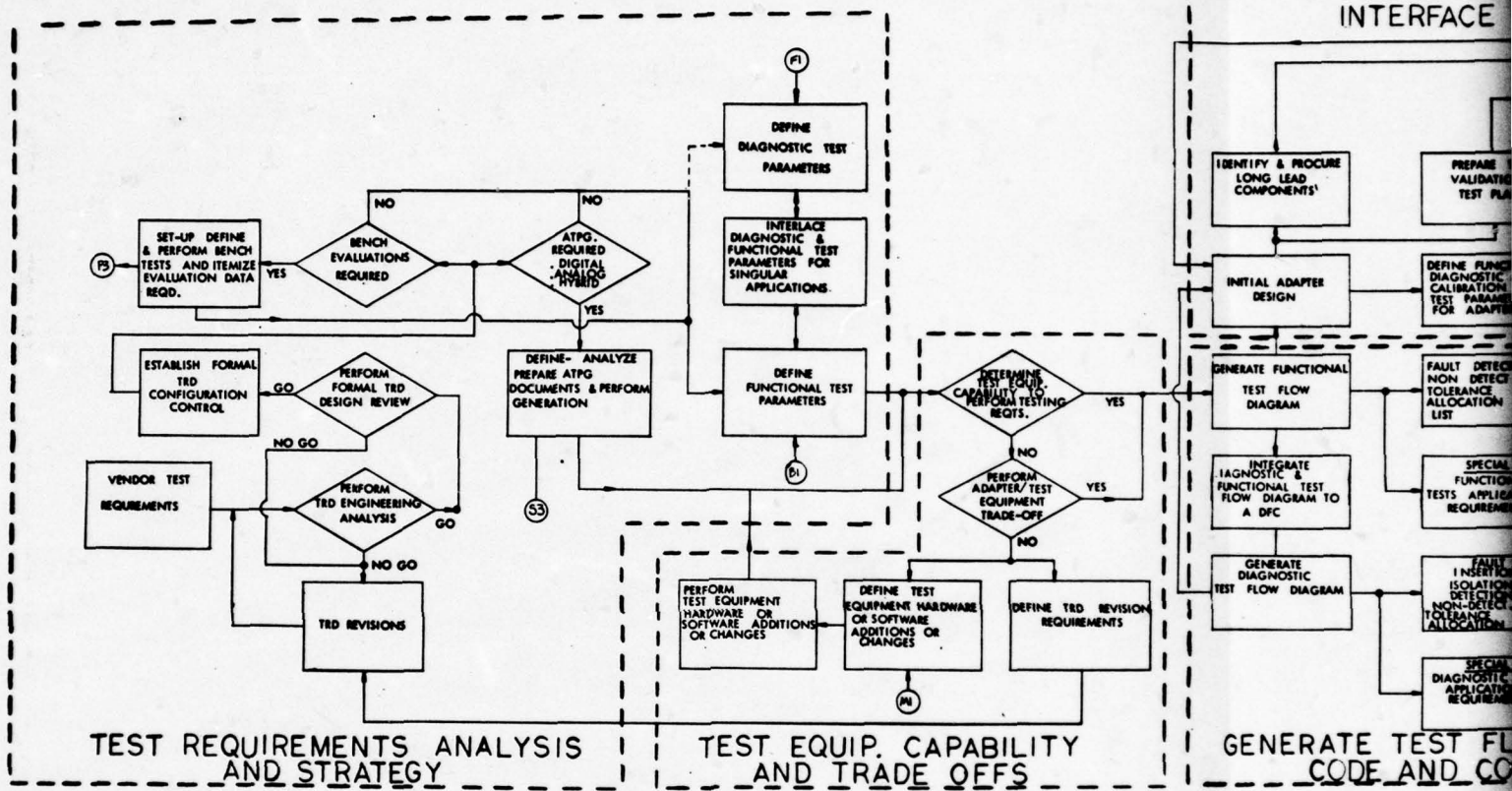
3.3.4 UUT Performance Specification (Component Functions)

The UUT performance specification, sometimes called the production specification is the prime definition document for the UUT. It is normally a standard format of scope, documents, design requirement and quality assurance requirement. The content of this specification is all encompassing in scope except for certain critical elements needed primarily to support the UUT in the future. This specification provides for design, fabrication, inspection, in-process control, in-process testing, functional testing, environmental testing and acceptance testing sometimes including the "first article acceptance requirements." The document normally requires the vendor prepare an Acceptance Test Procedure and the necessary test facilities and equipment to verify to the customer that the UUT meets its production specification requirements. Testing is normally performed on PSTE (Peculiar Special Test Equipment), peculiar to the vendor and as a function of that vendor's design, fabrication and previous testing experience. This PSTE can be anything from a hot-mock-up to a sophisticated testing system, but almost always it is still peculiar to that vendor. Many words of pro and con can be written concerning this type of specialization in testing by each manufacturer of UUT's. The best probably would be that at least the vendor can demonstrate that his UUT meets the production specification, and that all the precise elements of that specification have been met. Needless to say, there is a proliferation of test equipment in the making (or already made) but to date the economics of a continuing UUT supply source seem to demand a continuation of this method of test.

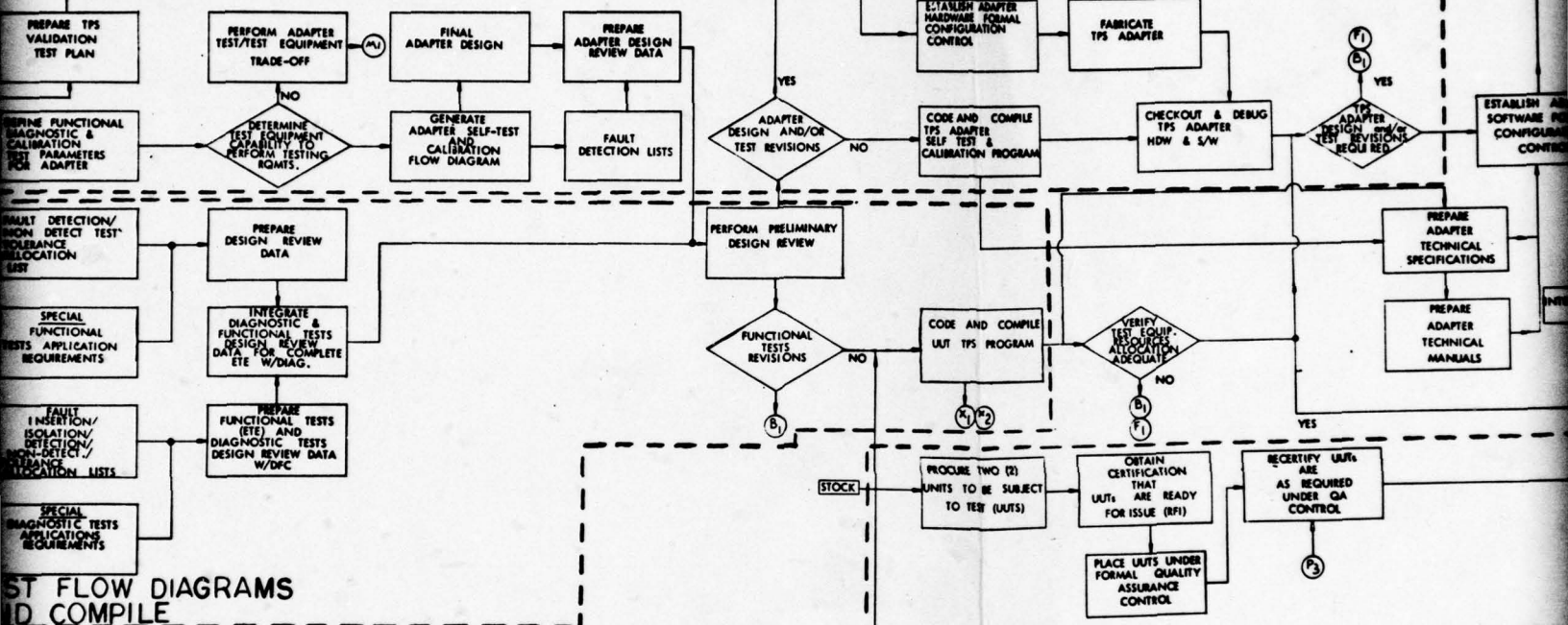


SIMPLIFIED TPS DEVELOPMENT BLOCK DIAGRAM

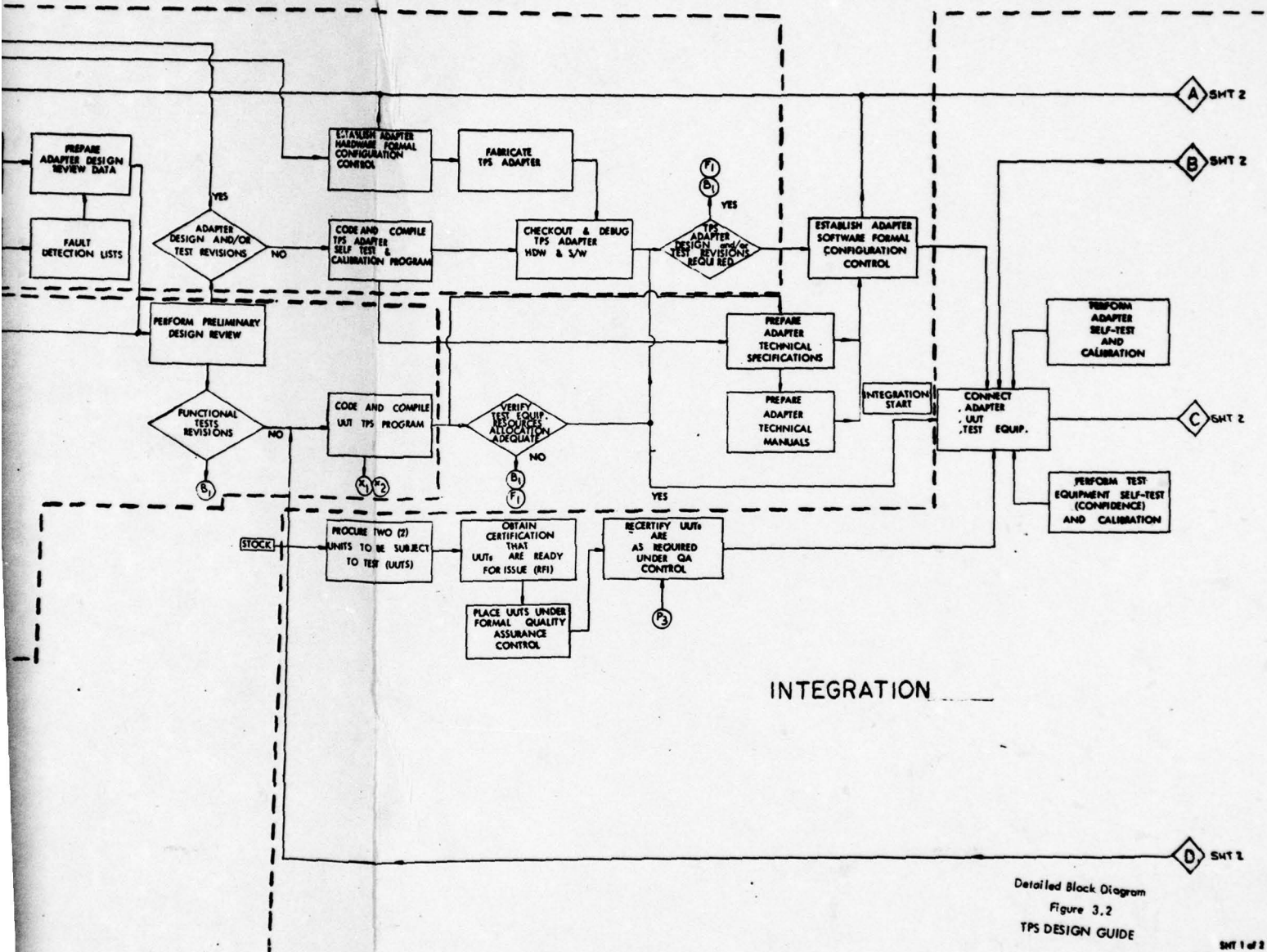
FIGURE 3.1

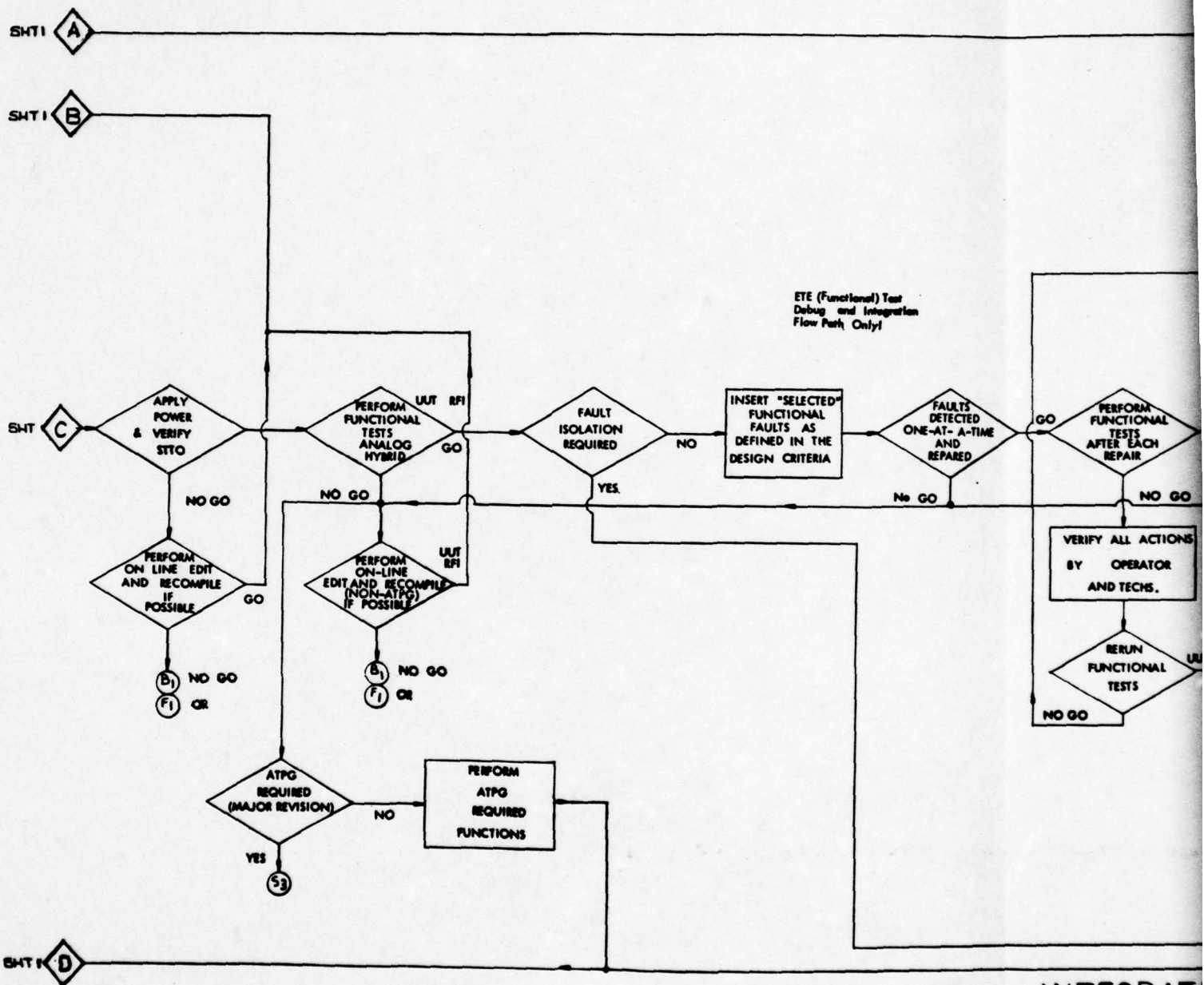


FACE ADAPTER DESIGN AND BUILD



INTEGRATE

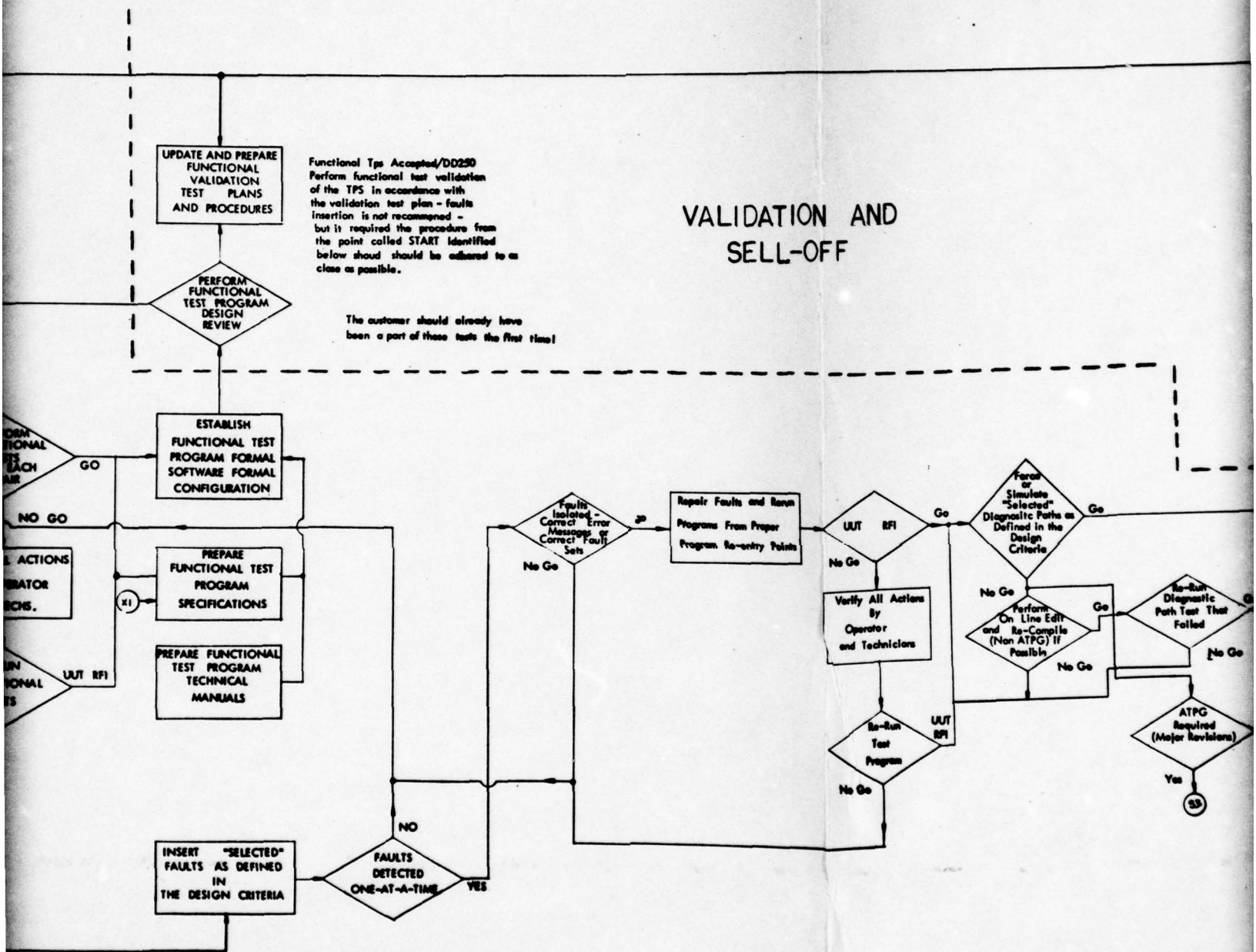




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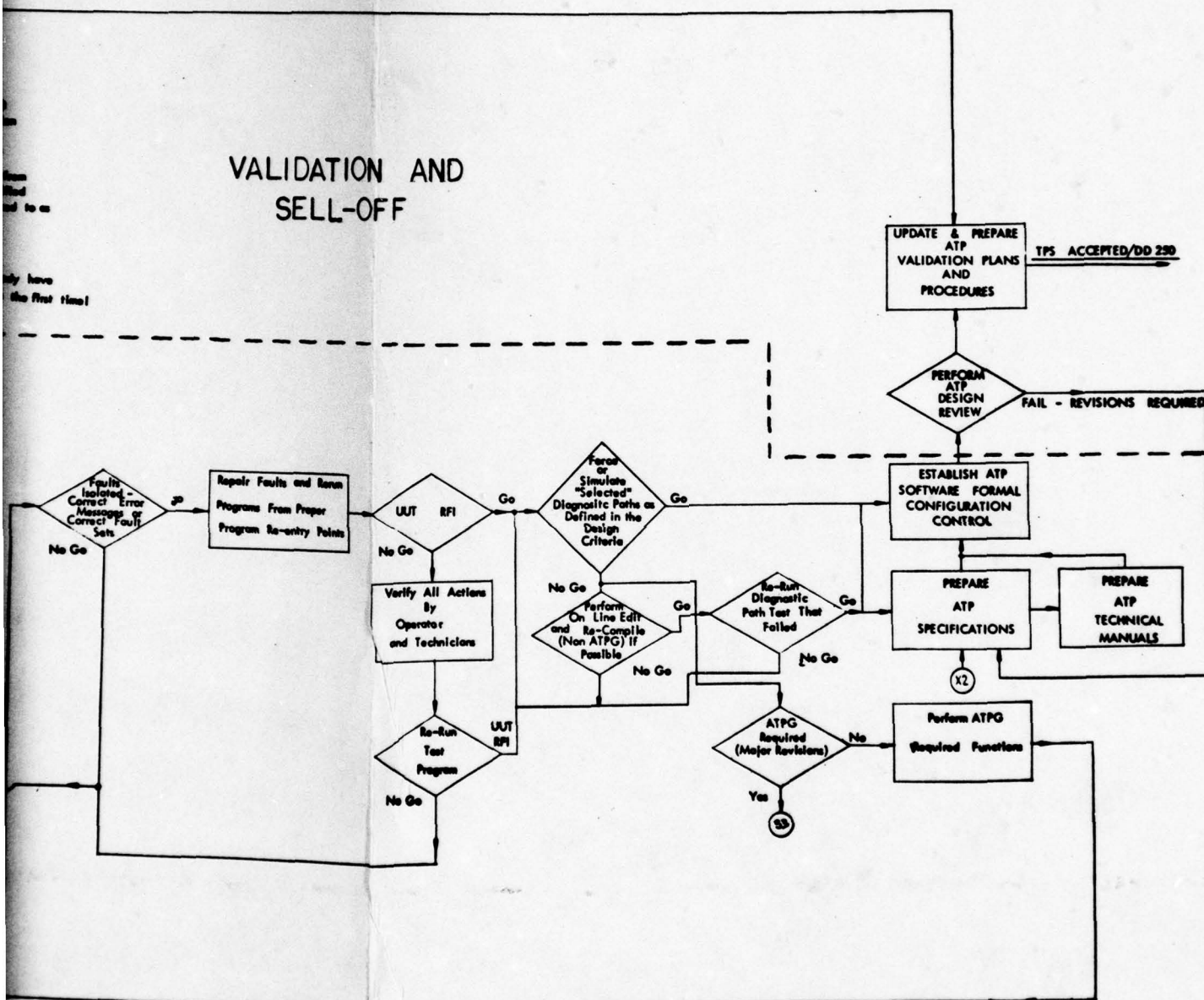
INTEGRATE

VALIDATION AND SELL-OFF



URATION

VALIDATION AND SELL-OFF



Detailed Block Diagram

Figure 3.2

TPS DESIGN GUIDE

SECTION IV

4.0 TEST REQUIREMENTS/STRATEGY

A major factor in the development of a test program is the generation of test requirement and test strategy information. This section will discuss the steps necessary to generate this information.

The items to be discussed in this section include:

1. UUT functional requirements and the critical parameters that must be determined to ensure an adequate test.
2. The test approach and test options that result from the functional requirements analysis.
3. The isolation ambiguities and their effect on the test approach.
4. Test tolerances and their relationship to the maintenance concept and level of test.
5. Testability and its importance in the test program development process.
6. The data required to determine the test requirements/strategy, and the data required to document the results.

4.1 UUT FUNCTIONAL REQUIREMENTS

The first step in determining the test requirements/strategy is to determine if a functional test is necessary. This analysis should be made without any consideration being given to the test equipment to be used, or even if test equipment exists to provide a truly functional test. This analysis should be based only on the needs of the unit to be tested.

The effective way to arrive at this decision is a somewhat reverse approach. That is, instead of asking the question, "What failures will be found by performing a functional test?" - the question should be asked, "What failures will NOT be found by performing a non-functional or static test?"

This decision is much easier to arrive at in SRU testing than it is in LRU testing. For example, in the case of SRU testing, the schematic or circuit diagram can be reviewed and if there are no peculiar timing circuits, oscillators or clocks embedded in the SRU, it can generally be assumed that a static test will provide a test sufficient to determine the operability of the SRU. Of course there are always exceptions, one of which is where the designer advertently or inadvertently designed in a race condition that only appears when the UUT is operating at speed, but these conditions are rare, extremely difficult to determine, will most likely be found in some other manner such as design proof or system level test, and will usually result in a design change. There is also the case where a device will operate perfectly normal at low speed, but fails to function properly as the speed is increased; however, this type of failure is rare enough not to alter the basic approach.

This approach is also valid in determining whether or not a functional test is required at the LRU level. It is not as simple a decision to arrive at because the LRU usually consists of a number of SRU's connected together in some manner not easily seen by a quick review. The system block diagram is generally of no assistance in making the determination because it is more a question of the types of elements used and the mechanization of those elements into a system that decides the question. For example, were static or dynamic memory devices used? Is there an oscillator or clock internal to the LRU, and if so, can it be disabled and controlled from an external source?

These and many other similar types of questions must be answered before the question of functional or static testing can be answered.

Because it is more difficult to make this decision at the LRU level, the optimum method would be to involve the designer of the LRU in the decision making process. This is not to say it should be his decision in total, because most designers feel that the only adequate test would be a full functional test. This is not true, but the designer's involvement is desired to determine the critical parameters that must be supplied to the UUT, or monitored by the test equipment.

An example of this is that in some types of data transmission such as Manchester where the clock to reconstruct the bi-phase coded data is encoded within the data, rise and fall times can be a very critical parameter. If the rise and fall times are too fast or too slow, it can result in erroneous data being received. This information should of course be contained in the system specification, but it is information the designer is quite aware of the importance of, and would place the necessary emphasis on it. On the other hand, there may be a voltage output from the LRU that comes from a regulated source and at a glance would appear to require a close tolerance measurement, but in the system the signal is actually used only to indicate the presence of power. The only measurement required on a signal of this type is one that indicates a voltage of some value greater than that necessary to overcome the threshold of the receiving device. This again is information the designer is quite aware of and by including this information in the test requirements will prevent a close tolerance measurement from being made on a signal that does not require it which could cause a failure indication when the LRU is in fact operable.

4.2 TEST APPROACH AND TEST OPTIONS

Once the UUT functional requirements have been established, it is then necessary to determine the test approach and the options available to that approach.

At this point, it is necessary to give some consideration to the capabilities of the test equipment. If, for example, a functional test is required, but no test equipment exists or can be procured with the necessary capabilities to allow this, then a part of the test approach would have to include the design of a complex interface adapter to provide the storage, buffering, unique timing, or data conversions to compensate for the inadequacies of the test equipment.

It should be pointed out in this instance that the test equipment with the capabilities most closely approaching the functional requirements of the UUT is not necessarily the correct choice. Take for example the case where the data has to be inputted to the UUT at a specific frequency of 10 MHz, and the choice is between a tester that is capable of providing data at 5 MHz and one with a maximum rate of 100 KHz. Consideration should be given to the types of devices required to ensure reliable capture of the data at the higher rate versus the devices required at the lower rate. The resultant noise generated by the faster data transfer rate should also be examined, and if test time is not a major factor, the tester with the slower rate should be given serious consideration. Cost would certainly enter into the decision process also, as the tester with the higher data transfer rate would in all probability be the more expensive of the two.

In addition to determining the type of test equipment to be used, the test approach should also include:

4.2.1 Configuration Audit

Establishing the configuration of the UUT that the test program is to be written for, and controlling that configuration throughout the development cycle. As changes to the UUT take place during the test program development period, they should be reviewed and the decision made as to whether they should be incorporated at the time or accumulated and included at the end of the development period. Major changes should of course be included at the time, but minor changes to the test unit that do not grossly effect the operation of the item can cause the development time to increase if they are incorporated as they occur. They should be accumulated and included at the conclusion of the development.

4.2.2 Computer Aided Program Preparation (CAPP)

Determining the need for computer aids in the UUT analysis process - the analog analysis aids such as CAPS and ISPICE can be of some use in simulating complex circuits and providing the test engineer with information on the expected results for a given set of conditions. In existing computer aided analog circuit design programs, whether it is used for design or analysis, the biggest limiting factor is the lack of accurate and complete models for active components such as transistors, op-amps, comparators, regulators, etc. For example, it is difficult if not impossible to include in the model all parameters and tolerances of an op-amp that will affect its operation, resulting in questionable accuracies of the analysis results. Any wide-band analog components just compound the problem.

Due to the lack of good models for active components, results from computer aided analysis generally have tolerances and uncertainties that are not suited for general simulation of complex circuits, followed up by detailed theoretical analysis.

Component failure mode analysis has been tried by using ISPICE with some success. However, the same problem with active component modeling was experienced in this application also, therefore, the same limitation applies.

The problem with active components modeling compounds itself when wide-band circuits such as RF or video are involved. With state-of-the-art circuits designs leaning more and more toward digital, the solution to the modeling problem does not appear to be forthcoming.

Computer aids in circuit analysis, with its inherent faults, can still be cost effective, particularly in large programs where many test engineers are doing circuit analysis. As with any tool, its usefulness can be enhanced if the user recognizes its shortcomings and applies it properly.

Another method for accomplishing this that has proven effective is the use of bench analysis. If the unit to be tested is available during the analysis period, some very useful information can be gained by performing bench evaluations to determine the reactions of complex circuits during certain failure modes. This information can of course be gained from a paper analysis, but the bench evaluation, if the necessary equipment is available, is faster and the results generally more accurate. If the bench evaluation is used, extreme care should be taken to ensure that no damage occurs to the UUT.

The bench evaluation method is most effective on analog circuits. For digital circuits, it would be of little value. The computer aid or the paper analysis are the only practical methods for developing digital test patterns. The computer aids in use today such as LASAR are commonly

called Automatic Test Program Generators (ATPG). Although they share this common name, there are differences in the way they operate. As a result of this, a part of the test approach is not only to decide if ATPG is to be used, but also the type of ATPG to be used. There are two general categories of ATPG even though their operation within these categories may differ. The two categories are:

- o Fault Dictionary
- o Guided Probe

The basic differences between the two is that the fault dictionary type applies patterns, accepts responses, and after evaluation of the responses outputs a list of "most probable faults." From this list the faulty component is identified. The guided probe type of ATPG applies input patterns, accepts responses, and if an incorrect response is received, the operator is given a message to connect a probe to some point in the circuit, and the response patterns are once again evaluated. This is repeated until the faulty component is identified.

Both types of ATPG are effective in the identification of failed components, and the decision on which one is the correct one for a given task has to be based on things such as:

- o The type of tester used. Some manufacturers supply ATPG that only runs on their systems, so if another type is to be used, a translator is required to allow it to run on any other test set.
- o The amount of simulation time available. The fault dictionary type of ATPG generally requires longer simulation run time than the guided probe type.

- o Accessibility to the UUT. If the guided probe type is used, the test operator must have access to the points specified by the probe messages.
- o Level of isolation required. The fault dictionary type of simulator generally provides a number of "possible faults," where the guided probe type will in most cases isolate to the failed component.

It should be noted that it is not always cost effective to use any type of ATPG. On simple digital SRU's, the modeling time, computer time and other associated cost cannot be justified, and manual pattern generation is the correct thing to do. This decision should be made during the initial circuit evaluation.

4.2.3 Test Level

Another important decision to be made is whether or not an end-to-end test is sufficient. If it is determined that diagnostic fault isolation is required, the level of isolation must also be decided. This decision is one of the largest contributors to the cost of a test program set and cannot be treated lightly. The development of a test program becomes more difficult as the component groups become smaller. If an end-to-end test is all that is required to support the required operational readiness level, then the development process should end at that point. If, however, fault isolation is required, the development is extended by an amount of time proportional to the isolation level required. Unfortunately, this is not a linear time extension. The optimum isolation level would of course be down to a single component 100% of the time. Even if this were possible, which it is not, the test program development time and the associated costs

would be beyond reason. At the other end of the scale is the simple functional end-to-end test. There is a point in between these two extremes that is the correct level for each support activity. The selection of this point is very important and should be based on factors such as:

- o Types of spares available at a maintenance site.
- o Quantity of spares available at a maintenance site.
- o Rework capability at a maintenance site.
- o Reliability of the unit to be tested.
- o Built-In-Test (BIT) and/or Built-In-Test Equipment (BITE) in the unit to be tested.
- o Accessibility of the unit to be tested.
- o Testability of the unit to be tested.
- o Complexity of the unit to be tested.

Having evaluated the above items, it should then be possible to determine if diagnostic fault isolation is required, and if so, what that level of isolation should be.

4.3 ISOLATION AMBIGUITIES

Isolation ambiguities can have an effect on many phases of the test program development cycle, the support of that program and the hardware the program was designed to support.

With ambiguity being defined as "capable of being understood in two or more possible senses," and isolate defined as "to select from among others," then a loose definition of isolation ambiguity would be "to select from among others in two or more possible senses." This is where the problem begins.

With a definition as stated above, it is not difficult to understand why no clear measurement of isolation ambiguity has ever been defined. It also becomes easy to understand that having an ambiguous statement with no way to measure the results, problems can be created.

Isolation ambiguity, however, has long been the accepted method of measuring test program quality, but it is in fact more a measure of the testability of the device being tested. The test program cannot improve on the testability of any piece of hardware. If access to the internal circuit elements was not made available through the use of things such as test points, partitioning into functional groups and mechanical packaging, the isolation ambiguity will be increased.

This fact must also be considered in determining the test approach. If the mission support level requires diagnostic fault isolation to small component groups, but the unit was not designed with the necessary visibility to allow this, the test program development becomes very complex. In this situation, manual probing is the only way to reach the desired ambiguity level.

When manual probing is required, not only is the development complicated by having to specify the probe points and route those signals into the test set, but once the program is released for use, the unreliability of probes that must remain connected to UUT's throughout the program run time can be a major source of problems. This is especially true in the case of conformally coated boards.

The only true solution to this is designing the electronics for better testability, but there is existing equipment that must be tested and until the design engineers become more aware of this need and learn the techniques necessary to implement it, the problem will be with us and must be considered in determining the test approach.

4.4 TEST TOLERANCES

One very important item that can have an effect on both the time to develop and the quality of a test program is the test tolerance. There are, of course, tolerances that must be established to ensure that the unit will perform its intended function as a part of a weapons system. These tolerances, however, are not necessarily the ones that should be used for test.

The test tolerance must be established to provide some guarantee that the unit will operate properly in the next higher assembly. The method used to accomplish this is a tightening of the tolerances the lower the level of test. This is called a Tolerance Cone. The tolerance cone as shown in Figure 2.1 shows the nominal design value and the build-up of tolerances as the level of test changes. For example, the depot level of test shows a wider tolerance than the factory level. At the factory level, the components used in the assembly are for the most part much closer to their design value.

This allows for tighter measurements to be taken, and these tighter measurements should be taken. When the unit becomes operational, the internally generated heat, aging and other factors will cause some drift away from the components design value. This can cause the factory level readings to become marginal although the unit still performs properly in the system.

This drift is a normal occurrence, and should be allowed for in the design. The design tolerance and the design proof testing should attempt to determine how far the unit can drift away from the design tolerance and still perform as intended in its next higher assembly. This design proof type of testing should not be carried throughout the higher levels, but it all too often is. This results in unnecessary rejection of operational units.

4.5 TESTABILITY

The most important ingredient to a successful test program is something that must take place long before the development begins. That ingredient is the testability of the unit to be tested.

The importance of a unit being designed to be tested has been mentioned previously, and cannot be over-emphasized. The test program cannot improve the testability of the unit. It can only take what has been made available and develop the best possible program from that.

Every piece of electronics equipment that has ever been constructed can be tested in some manner and to some extent. How extensive that test can be depends in part on how accessible that equipment is to the tester. If it is impossible to get to the internal devices, it is still possible to perform

some type of test using only the input/output signals that are available in the system configuration. This does allow the system function to be tested, but may require simulation of the other portions of the system to perform essentially a hot-mock-up-type of test. In some cases, this can be an adequate test.

If the system configuration signals are all that are available, it does make the use of automatic test equipment and automatic test programs more difficult. It generally means very complex interface devices are required, and even with the complex ID, no meaningful fault isolation would be possible. This is true at both the LRU and SRU levels, but as stated before, if this is all that is required, there is certainly no need to incur the additional expense involved in developing a truly testable device.

If, however, a thorough test with fault isolation to small component groups is required, it is necessary to provide access to the internal components. In the case of an LRU, these components would be the SRU's that make up the LRU. Critical signals that allow groups of SRU's to be isolated from each other, signals that allow functions to be separated, signals that assist in the evaluation of the operability of the device - must all be provided to the tester through the use of test points or test connectors. In the case of SRU's, large numbers of components on a card with limited I/O may appear attractive to the mechanical packager, but it is not very conducive to the test program development effort. Large multi-function circuit boards make the task of isolation to small component groups very difficult without the use of extensive probing. This is never desirable. It increases the test setup time, the test run time and can result in an unreliable program.

The above items are problems that occur after the program has been developed. The problems that must be faced during the development period are problems

that can extend the development time to unreasonable lengths. Some of these problems are:

- o The designing of complex interface devices.
- o Selection of proper probe points.
- o Routing the probe points into the tester.
- o Determining the proper probe to use.
- o Initialization of digital circuits.
- o Component isolation in feedback loops.

These problems can for the most part be avoided if the device to be tested was designed to be tested by allowing internal access, by allowing the test equipment to control direct set and reset lines, by allowing feedback loops to be broken, but they must be designed in. They cannot be added by the test program developer. He can only take what has been made available to him, and depending on the required isolation level, design the interface device and add the probe points necessary to achieve the specified isolation ambiguity.

Testability has recently been receiving a considerable amount of discussion by the ATE industry, but has not yet received the necessary emphasis by the electronic equipment manufacturer. Until the proper emphasis is placed on it at the designer's level, the problems the test program developer must face will continue with the result being long and costly test programs with less than the desired level of isolation.

FIGURE 4.1

The Testability Checklist is formatted in a way that allows a yes or no answer for each of the items. It is not intended to make a UUT more testable because at this point in the development cycle the design is beyond this. The checklist is intended to provide the test program developer with some visibility as to just how testable the UUT is.

FIGURE 4.1

TESTABILITY CHECKLIST

Line Replaceable Unit

| | <u>No</u> | <u>Yes</u> |
|---|-----------|------------|
| Built in test (GO- NO GO) | — | — |
| Built in test (Isolation) | — | — |
| Test connector(s) provided | — | — |
| Static test acceptable | — | — |
| Clock control provided | — | — |
| Initialization capability | — | — |
| Common module connector type | — | — |
| Replaceable large sub-assemblies (P.S.) | — | — |
| Plug-in modules | — | — |
| Test information provided by manufacturer | — | — |
| Input/Output devices compatible with tester | — | — |
| Test points buffered | — | — |

TESTABILITY CHECKLIST (Cont'd)

Shop Replaceable Unit

| | <u>No</u> | <u>Yes</u> |
|--|-----------|------------|
| Can feedback loops be interrupted | — | — |
| Can memory elements be initialized | — | — |
| Complex elements (i e., UARTS & microprocessors) mounted in sockets | — | — |
| External clock control | — | — |
| Long buss lines interruptable | — | — |
| Test points buffered | — | — |
| Can long counter chains be broken | — | — |
| Wired OR's minimized | — | — |
| Clearly identified components | — | — |
| Sufficient component mounting clearance for attaching test clips | — | — |
| Test information provided by manufacturer | — | — |
| Input/Output devices compatible with tester | — | — |
| Module keying defeatable | — | — |

4.6 DATA REQUIREMENTS

The data required to develop functional and diagnostic LRU and/or SRU test programs for automatic test is divided into three (3) categories:

- o UUT Supplier Data
- o TPS Development Data
- o Deliverable (User) Data

4.6.1 UUT Supplier Data

The UUT source documentation defines the UUT operating characteristics and performance requirements and generally comprises the following:

- o UUT Design/Performance Specification.
- o Factory and Operational Maintenance Test Procedures, Technical Manuals, and other related documentation.
- o Schematics, Wiring Diagrams, Manufacturing Drawings, etc.

If the source information completely represents a current and complete definition of test requirements, then the test design engineer can proceed with TPS design. However, if sufficient current data is not available, the data must be generated through design analysis, bench testing and/or other techniques appropriate to the UUT. Regardless of the source used, UUT performance requirements must be defined and documented prior to detailed test design. The test design engineer cannot effectively generate an accurate and complete test without guidance in the area of UUT performance. Without proper performance/failure mode data, the actual support requirements of the UUT may never

be fully appreciated. Testing based on inadequate data may fall short of UUT support objectives in the field, or could well result in testing too stringently and result in an unduly high rejection rate. In practice, when dealing with developmental UUT's, the source documentation package is often incomplete and/or in a state of flux. This necessitates the requirement for formal documentation change control. Each subsequent documentation change must take into account software impact and its relationship to the test program effort.

The list of specific data required is:

- o Schematics/Logic Diagrams
- o Assembly Drawings
- o Parts Lists
- o Component Specifications Control Sheets
- o Production/Acceptance Test Procedures
- o Compatibility Reports (Description of Operation)
- o Photographs
- o Critical Initialization Procedures
- o Test Patterns (I/O Sequences)
- o Wiring Diagrams/Pin Lists
- o Signal Waveforms and Timing Diagrams
- o Manual Adjustment Procedures
- o Power Supply Voltage and Current Requirements
- o Cooling Requirements
- o Loading Requirements

4.6.2 TPS Development Data

During test program development, a TPS data package is developed which is the sole receptical of all design/development information during program development and also a complete history of the development process. This data package is utilized for monitoring test development progress and management control throughout the life of the TPS. Thus, at the completion of the test development program, a completely current TPS design data package is available consisting of the following:

- o Diagnostic Flowcharts (DFC) - The step-by-step flow of the test program. The flowchart is generated from the List Requirements Documents and is used as the "outline" for generating the code.
- o Fault List - A list of possible failures that can occur in the Unit Under Test (UUT). The list can be used to select faults to verify the test program if that method of program verification is used.
- o Component Checklist - A list of all components on an SRA showing the failure modes. To be used to verify that a test was written to detect that mode of component malfunction.
- o Probe Point Designations on Assembly and Schematic Drawings - Probe points that are selected by the test program developer to aid in the isolation of a failure are shown on these drawings.
- o Non-Ambiguity Ratio Calculations - The calculations that show the number of failure messages, and the

number of components in each failure message that could possibly contribute to the malfunction.

- o Non-Detectables/Non-Functionals List - A list that indicates those components that if a certain type of failure occurs, such as one resistor in a parallel resistance network open, the failure cannot be detected using normal test methods.
- o Select-At-Test Components Handling Documents - The information that details the parameters to be observed, and the type and range of components to be used in the selection process.
- o Circuit Analysis Work Sheets - The work sheets used by the test program developer in the analysis phase of the development. The sheets are useful if changes are required later in the development process, and if changes in the UUT configuration take place after the program is operational.
- o Functional Block Diagrams - Block diagrams that show the functional operation of the UUT which can be useful in helping to determine if a functional or static test is required.
- o Interface Device (ID) Design Data - The interface device design data details the information required to build the ID.
- o Program Listing(s) - The listing of the test program that contains the detailed test information that results from the code and compile phase of the development.

- o Test Program Instruction (TPI) - The information required by the test operator to set up and execute the test program is contained in the test program instructions. Information such as cautions and warnings, probe point details, and select-at-test requirements should also be included in this document.

4.6.3 Deliverable Data

During normal operational use, the ATE technician/operator requires a minimal amount of information to enable him to perform the test program. The operator must first have a means of identifying and accessing the proper configuration information. The data must then provide him with necessary instructions for interfacing the UUT and the test program with the tester and the instructions to carry the test to its proper conclusions.

Maintenance/Test Program supplementary data in the form of UUT to tester interface drawings, and test description information may be provided to facilitate on-station (ATE) troubleshooting and ambiguity group breakdown.

Deliverable data will include:

- o Test Program Instructions (TPI's)
- o Program Listing(s)
- o ID Design Data -
 - Top Assembly Drawing
 - Nameplate Drawing
 - Layout Drawing
 - Wire List(s)

- o Test Program Tape/Disc (TPT/D)
- o Master Test Program Set Index (MTPSI)
- o Maintenance Support Data -
 - Test Interconnection Diagrams
 - Circuit Schematic (Functional Flow)
 - Make from Instructions (Parts Modification)
 - Description and Theory of Operation in LRU
 - Test Descriptions

SECTION V

5.0 CODE AND COMPILE

In the past, software generation has been treated as a secret art of select software specialists. This is no longer the case; in fact, the best software can be generated by an experienced test engineer whose ability spans both test techniques and an understanding of the ATE language. The test program design should include the following elements to reduce the total development costs:

- o Hardware/Software Interface Reference Material
- o Test Program Instructions (TPI)
- o Code and Compile Techniques

This section discusses the procedures required to reduce the code and compile development to a cost effective technique and to provide meaningful test documentation for the site user.

5.1 REFERENCE MATERIAL

The selected ATE User's Guide should be reviewed to determine whether it contains the following criteria. If not, it will be necessary to summarize certain data for quick reference and usage during code and compile and on-station testing.

The software language should be described for each mode of tester operation, showing the required field and options which must be filled in during the coding operation. On the same page or following page, the ATE pins on which each signal appears should be available and must be summarized to avoid the need of referring to other documents. These are best described by simple block diagrams showing the input and output pins and the software fields which are related to each pin. In addition, descriptions, using the same format, should be made for

any special interface devices described in the previous sections. Where large interface connectors are used, a matrix diagram, showing pin numbers and related ATE functions, should be made.

5.2 TEST PROGRAM INSTRUCTIONS (TPI)

The information for the Test Program Instruction is prepared by the test programmer, but the ultimate user is the tester at the site. The Test Program Instructions (TPI's) should be formatted and a simple checklist prepared for the programmer to fill in. This will standardize the TPI and reduce the language barrier between the programmer and the technical writing group. Working with the TRD, the programmer can block out the operator actions required to connect the setup, load the program and run the test, thus minimizing the time required to prepare the TPI, if it were saved to the last.

Operator Action messages may be prepared in advance, thus eliminating errors caused in a two-step operation. Simple test diagrams should be prepared for each setup to enhance the understanding of the UUT/ATE operation. These sketches may become a part of the final TPI to aid in test diagnostic troubleshooting.

5.3 CODE AND COMPILE TECHNIQUES

Code and Compile procedures can be simplified by preparing standard messages and routines in advance. These procedures should be appended to the reference material described in Section 10.1. A brief description of some of the techniques which should be included are:

- o Standard Messages
- o Structured Programming
- o Annotation
- o Entry Points

5.3.1 Standard Messages

Standard messages should be prepared to reduce preparation time required for individual systems. These should include, as a minimum, initial setup and configuration check, pass/fail, adjustments, often-used operator actions, and advisories. These messages should use standard spacing for easy reading. If variable fields are required, the standard message may be prepared as a subroutine with the variables being passed on as arguments. It can also be prepared on a standard coding form, with blank fields for the programmer to insert the correct variables.

5.3.2 Structured Programming

Standard procedures should be prepared for uniform structuring of the program. Using the TRD as an outline, the general test flow and coding strategy can be determined. Types of tests and test connections can be grouped into categories. Standard subroutines can be prepared. Some often-used procedures can be modularized and compiled into many programs with proper software procedures for a given compiler. Since the finished program listing should be a part of the documentation, the use of subroutines should consider the visibility of the completed form. Is it readable? Are nested routines required? Does the compiler print out a concordance? These answers will determine the extent to which subroutines can be used without masking the test flow from the test user.

5.3.3 Annotation

The coded listing should be annotated with comment cards to assist the tester in identifying the test against the TRD. Comment cards can be prepared during the initial test planning and will form an in-line table of contents for the tests. Test numbers should be sequential with allowance made for revisions. For example, test should progress in tens, with diagnostic branches having some

relation to the functional test from which it branched. The display should use annotations to advise the operator of the general test section which is being run.

5.3.4 Entry Points

Entry points should be placed at the beginning of each major test series. The use of entry points must consider the need for safe-to-turn-on and initialization procedures. These should be clearly annotated in the TPI.

SECTION VI

6.0 INTERFACE DEVICE (ID) DESIGN

The Interface Device (ID) design requirements are determined by the UUT functional requirements (Section 4) and the ATE Characteristics. This section will discuss the steps necessary to generate the ID design.

The items to be discussed in this section include:

1. Level of complexity
2. Self test requirements
3. UUT protection
4. Mechanical considerations
5. ID checklist

6.1 LEVEL OF COMPLEXITY

The UUT functional interface requirements described in Section 4 will determine the size and complexity of the ID. UUT signal characteristics are itemized pin-by-pin, including the electrical characteristics, such as voltage, impedance, frequency, rise time, etc. The number and types of signals are then summarized, including the maximum number of simultaneous signals for each signal type. This summary should be made without regard to the ATE to be used. Terminology should be compatible with the test flow diagram prepared as part of the Test Requirement Document (TRD). The ID check list will group these requirements as inputs/outputs from the UUT for:

- o Grounds and shields
- o Power requirements
- o Analog stimulus/response
- o Digital stimulus/response
- o Timing and control

- o Probing requirements
- o Special requirements

The UUT input/output summary is then compared to the ATE signal characteristics described in Section 10 to determine full compatibility. Where I/O does not match, additional analysis must be made to determine the most cost effective method of matching the requirements by adding elements in the ID. ID complexity will be minimized by the use of ATE with universal switching interface.

ID elements may include switches, relays, buffers, amplifiers, registers, etc., and, if necessary, SRU circuitry from the parent UUT to achieve full compatibility. In extremely complex cases, the design should consider the use of common complex IDs to satisfy a family of UUT requirements. In the case of simple IDs, every attempt should be made to utilize the same ID for several UUTs.

The cost of the complex design and subsequent self-test requirements must be traded off with the cost and utilization of more sophisticated ATE. Such trade-offs must consider the high logistic cost of a manual test alternative which would require more personnel and training throughout the life cycle. The use of a standard ATE data bus will allow cost effective design of special requirements in a common ID which is controlled by the standard ATE.

6.2 SELF TEST REQUIREMENTS

ID Self Test is mandatory on even the simplest ID. If the usage of the test equipment is high, experience has shown that self test will save time in all phases of development and site usage. This is due in part to the wear out of mating connectors. All active signals should be wrapped around so that all sources are activated into every measurement device used by the system. The order of priority should be as follows:

- o Internal (to ID) wraparound without disconnecting UUT
- o Minimum swapping of external connectors
- o Wraparound shorting plug substituted for the UUT

All self test techniques should avoid removing any ATE interface connectors whenever possible as this could cause undetected mating problems during the test.

6.3 UUT PROTECTION

The UUT functional characteristics should include requirements for protection of the UUT against damage by the ATE or vice versa during turn on/off and transient conditions. Power sources should be designed to crowbar in case of malfunction. It may be necessary to design certain protective circuitry in the ID, such as voltage limiters on voltage sources to TTL circuits.

6.4 MECHANICAL CONSIDERATIONS

The mechanical configuration of the interface device is determined by:

- o Number of input/output connectors
- o Amount of signal conditioning required for ATE compatibility
- o Cooling requirements for UUT and/or ID
- o Holding fixtures required for UUT

Physical size should be minimum so that handling and storage problems are minimized; however, a 20% expansion capability should be provided for in the initial design.

Any signal conditioning circuitry within the ID should be modular in construction and readily accessible via access doors.

Captive cabling should be minimized where general purpose cabling can be provided.

6.5 ID CHECKLIST

Table 6.1 is an ID checklist for summarizing all requirements for the design review. The checklist should be updated as changes are required to maintain complete visibility of the design.

TABLE 6.1

INTERFACE DEVICE CHECKLIST

| | | <u>Yes</u> | <u>No</u> |
|---|-------|------------|-----------|
| Number of signals | | | |
| Digital | _____ | | |
| Analog | _____ | | |
| Power | _____ | | |
| Special signal wiring required (i.e., twisted pair, coax shielded wire) | | _____ | _____ |
| Digital quantity | _____ | | |
| Analog quantity | _____ | | |
| Power quantity | _____ | | |
| Buffering required | | _____ | _____ |
| Digital quantity | _____ | | |
| Analog quantity | _____ | | |
| Signal conversion required | | _____ | _____ |
| Digital quantity | _____ | | |
| Analog quantity | _____ | | |
| Special timing required | | _____ | _____ |
| Digital quantity | _____ | | |
| Analog quantity | _____ | | |
| Special control required | | _____ | _____ |
| Digital quantity | _____ | | |
| Analog quantity | _____ | | |

INTERFACE DEVICE CHECKLIST (Cont'd)

| | <u>Yes</u> | <u>No</u> |
|--|------------|-----------|
| ID power requirements _____ | | |
| Probe requirements _____ | | |
| ID self-test required | — | — |
| UUT removal required for self-test | — | — |
| UUT electrical protection required | — | — |
| UUT cooling required | — | — |
| ID cooling required | — | — |
| UUT holding fixture required | — | — |
| Common ID feasibility evaluated | — | — |
| General purpose cabling evaluated | — | — |
| Access to ID active components evaluated | — | — |

SECTION VII

7.0 INTEGRATION

The integration of the test program requires the bringing together of all the previously developed pieces to verify that the test strategy was proper, the interface device design is as required, the test set is adequate and the test program instructions are correct.

The integration process simply stated is to verify that the test program will pass a good unit, reject a bad unit and, if rejected, determine the cause of failure.

Prior to the first test on the ATE, a safe-to-operate procedure should be prepared to check all power lines and avoid damage to the ATE in case of ID wiring errors. The next phase would be a manual step through of each test to determine at a deliberate speed, that each test is properly coded and that the UUT is responding to the test commands. When this is complete, a functional test can be run with a known good UUT. The program is then forced down each major diagnostic branch to insure that all coding is correct. The remaining checks will consist of fault simulation and fault insertion. The number and method of simulating faults is a major contributor to integration costs. It is, therefore, important to trade off the number of faults against the program ambiguities in the final analysis.

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SECTION VIII

8.0 DESIGN REVIEW

During the course of test program set development, formal design reviews between the TPS contractor and supplier should be accomplished.

Experience has shown that two (2) formal reviews are required and can be referred to as Preliminary and Critical.

8.1 REVIEW FORMAT

The TPS supplier technical representative and the contracting agency representative should jointly chair the meeting.

The supplier should present an overview of the TPS to familiarize all attendees with the test philosophy and strategy.

During this presentation, the contracting agency representative s should be adding or deleting questions from a list which has been pre-prepared having reviewed the data prior to the design review.

At the conclusion of the supplier presentation, the contracting agency should address his list of questions until mutual satisfaction is reached.

Detailed minutes of the design review should be recorded and any open action items should be summarized and responsibilities/schedules assigned for closure.

Action item closure reports should be prepared with a detailed description of the corrective action taken.

Mutual concurrence of action item disposition should be required prior to commencing TPS debug and validation.

8.2 PRELIMINARY DESIGN REVIEW (PDR)

The PDR should be conducted upon completion of test analysis which results in a detail flowchart and adapter requirements definition.

Items to be reviewed are indicated in the checklist Figure 8.0-1.

8.3 CRITICAL DESIGN REVIEW (CDR)

The CDR should be conducted at the completion of TPS debug/verification. Any anomalies revealed during this review also require action item closure reports prior to the conduct of the TPS Acceptance Demonstration.

The product of this CDR should be a mutually agreeable set of tests which will demonstrate the ability of the TPS to diagnose the UUT and isolate failures.

8.4 CHECKLIST

The design review checklist is purposely structured to accommodate both PDR and CDR in single document. The checklist should be an integral part of a permanent engineering data book assembled by the TPS development engineer and maintained throughout the total development process.

Figure 8.0-1 suggests an itemized list of checks to assure a proper review.

Figure 8.0-1

Test Specification

1. All PDR Items
2. Source Code Listing
3. Formal Adapter Drawings
4. Final DFC
5. Final Source Code Listing
6. Recommended Spare Parts List

No.

[illegible]

Figure 8.0-1 (Cont'd)

| III UUT-ATE INTERFACE DEFINITION | | Yes | No |
|---|--|-----|----|
| A. PDR Items: | | | |
| 1. Determination of I/O Signals & Power Reg. | | | |
| 2. ATE capable of providing I/O & Power | | | |
| 3. Adapter requirements determined | | | |
| 4. Mechanical sketches conform to requirements | | | |
| 5. Proposed adapter conforms to negotiated basic design | | | |
| B. CDR Items: | | | |
| 1. Formal adapter drawings agree with PDR | | | |
| 2. Formal drawings complete and accurate | | | |
| 3. Final DFC fully tests UUT | | | |
| 4. Final source code listing reflects DFC | | | |

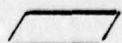
| IV TEST STRUCTURE EVALUATION | | Yes | No |
|---|--|-----|----|
| A. PDR Items: | | | |
| 1. Engineering Analysis Summary | | | |
| a. Circuit analysis complete | | | |
| b. Test parameters guarantee operation at next higher assembly | | | |
| c. ATE tolerances calculated for each test | | | |
| d. ATE tolerances ratio'd with circuit specification tolerances | | | |
| e. Ratios 10% for all tests | | | |
| 2. DFC | | | |
| a. All UUT functions fully verified | | | |
| b. Reflects circuit analysis | | | |
| c. Probing reviewed | | | |
| d. SAT procedures are accurate | | | |
| e. Grounding is adequate | | | |
| f. Tolerances are same as engineering analysis definitions | | | |

Figure 8.0-1 (Cont'd)

| | | Yes | No |
|----|---|-----|----|
| B. | CDR Items: | | |
| 1. | TPS listing test numbers conform to DFC test numbers | | |
| 2. | TPS listing accurately represents DFC | | |
| 3. | All displays are using standard message format | | |
| 4. | Test Program Instruction (TPI) test numbers conform to DFC & ATLAS listing test numbers | | |
| 5. | TPI contains accurate test setup instructions | | |
| 6. | TPI contains clear SAT instructions | | |
| 7. | Spare parts list accurate | | |

| V SUMMARY | | Yes | No |
|-----------|---|-----|----|
| A. | PDR Items: | | |
| 1. | Engineering analysis summary complete | | |
| 2. | Adapter requirements complete | | |
| 3. | DFC complete | | |
| 4. | Action item no. _____, _____, _____ clear | | |
| B. | CDR Items: | | |
| 1. | TPS source code complete | | |
| 2. | Formal adapter drawings complete | | |
| 3. | Final DFC complete | | |
| 4. | TPI complete | | |
| 5. | Action item no. _____, _____, _____ clear | | |
| C. | Deliverable items complete | | |

VI COMMENTS AND NOTES



PDR Date _____

PDR OK _____

Date _____

CDR Date _____

CDR OK _____

Test Engineer _____

Test Engineering Manager _____

SECTION IX

9.0 ACCEPTANCE TESTING

The most important factor to be evaluated in the acceptance test of a Test Program Set is to evaluate its accuracy and usability. There are only three functions of the TPS and they are as follows:

- o Correctly identify a "good" UUT.
- o Correctly identify a "bad" UUT.
- o Correctly identify the "cause" of a UUT failure.

The inability of a TPS to perform these functions can generally be attributed to the following:

- o Inappropriate use of test techniques.
- o Improper test limit derivation.
- o Improper ordering of tests.
- o Incomplete testing.
- o Incorrect or unclear operator instructions.
- o Unidentified interface device failure.
- o Improper application of the test system.

Acceptance testing should concentrate on both usability and accuracy of the TPS.

9.1 FINAL DESIGN REVIEW

If structured properly, the final design review should serve as a tool in identifying areas of potential weakness of the TPS. Test techniques, overall test strategy and the testing sequence should be carefully reviewed from a functional block diagram of the UUT. The interface device should be reviewed, and if complex, the adequacy of the self test reviewed. It should be verified that all functions of the UUT are tested and several of the test limit derivations explained. The application of each different function of the test system used should be evaluated. The operator instructions should be reviewed for clarity and the program documentation evaluated as to the use of making a program change. If all of the above items are reviewed, a better confidence in the TPS quality can be gained.

9.2 DEMONSTRATION

The demonstration of the test program set is the final check of its quality prior to being used in an actual military test and repair environment. It is here that the UUT will be exercised by the TPS on the test system. It is recommended that two (2) UUT's be used for this demonstration. This will allow a better observation on the adequacy and accuracy of the test tolerances.

A better measure of the clarity of the operating instructions will be gained if the cognizant procurement engineer that participated in the final design review actually runs the TPS.

It is suggested that a small team of test engineers select the faults for each UUT. This fault list should be based on the recommendations of

the final design review and also concentrate on faults that have a higher probability of occurring in the UUT. The number of faults selected should be directly proportional to the number of failure modes. The UUT should be restored after each fault with the TPS verifying the repair of the UUT. It is the opinion of the authors that the number of faults inserted not be large, with penalties added for each missed fault. A suggested penalty measure might be as follows:

Faults Correctly Isolated

Penalty

90%

Fix missed faults, add 1
penalty fault per miss.

75%

Fix missed faults, add 2
penalty faults per miss.

< 75%

Fix missed faults, add 3
penalty faults per miss.

If more than one test system is available, the TPS should be run on two different systems.

9:3 DELIVERABLE DATA

All data generated during the generation of a test program set should be considered as deliverable data. The test program tape/disc, operating instructions, interface device and drawings, program listing and UUT data are the usual items considered as deliverable data. Other data such as design review minutes and notes and the engineering notebooks and flow-charts are invaluable when doing maintenance on the test program itself.

A well annotated listing can be sufficient for maintenance if done as a stand alone document, but a specification has never been generated to assure that the listing will contain the necessary technical strategy and maintenance information.

9.4 WARRANTY

Once the TPS has been demonstrated and sold off, the contractor usually has no responsibility to fix errors that are discovered. Rather than have an extensive formal demonstration, a warranty period imposed on the contractor would quite likely produce a better overall product. It would force more thorough internal technical reviews and minimize the cost of overall software maintenance.

SECTION X

10.0 ATE CONSIDERATIONS

Automatic Test Equipment (ATE) design and testability should be treated in the same manner as the operational electronics it was designed/selected to support. The ATE must be designed for versatility, reliability and maintainability. ATE hardware and software design considerations which impact total operational life cycle costs are:

- o ATE Standardization
- o ATE Expandability
- o ATE Availability
- o Human Factors
- o Documentation

10.1 ATE STANDARDIZATION

The operational electronics level of repair (LOR), discussed in Section II, concluded that no single ATE could satisfy all testing requirements for medium or large electronic systems. A suite of ATE will be required to satisfy all testing requirements at the Operational, General Support, Depot and Factory levels. Each ATE subsystem should be selected with the maximum commonality within cost constraints.

10.1.1 ATE LOR Considerations

At the Organizational Level (O-Level), higher availability will be achieved by expedited fault isolation and modular replacement using Built-In-Test (BIT). Portable ATE (contact testers) would result in less ambiguity in O-Level testing and, in some cases, allow isolation to the SRU level. The ATE at the

Organizational Level should, therefore, depend on the Operational Electronics MTTR requirements, including the feasibility of O-Level spare parts. At the General Support Level (GS-Level), an ATE of modular design using common equipment from an approved list will be configured for support of commodity oriented equipment, such as communications-electronics, missiles and avionics. Starting at the GS-Level, ATE commonality with the Depot and Factory Repair levels is a feasible and cost-effective goal. A common core tester, such as the AN/USM-410 (V) should be selected for LRU and SRU testing at GS-Level. Using MIL-STD-1513 to predict ATE work load, a given GS installation can be equipped with ATE augmented for RF, digital or hybrid testing of both LRU's and SRU's.

When very complex LRU's are tested at GS-Level, long tests times (run time) should be avoided by better testability and BIT to improve MTTR and reduce the quantity of ATE at the site. Available spare modules will determine the extent on-line module swapping will be feasible to reduce the logistic pipeline. Manual operations and adjustments in ATE testing decrease station throughput. LRU's with excessive adjustments should be off-loaded to manual testers or general purpose ATE designed to enhance operation and adjustment techniques.

Depot Level ATE should overlap the GS-Level design, but include test capability of low failure LRU's and SRU's to minimize the vendor repair requirements. Work load predictions will determine initial implementation. Future expansion will depend on the ease of software development which can be accomplished using local manpower. This requirement enhances the need for a common easily programmed language such as ATLAS.

The vendor repair level should contain the tightest tolerance test capability and should be designed to electrically simulate the Depot and GS-Level test

interface. It is usually not feasible to require the vendor to use the standard ATE.

10.1.2 ATE Performance Characteristics

Table A shows the performance characteristics of the AN/USM-410 (V Equate tester and the expanded capabilities with the augmented RF and universal switching modules. A comparison of these capabilities against the operational electronics test requirements will determine the additional test requirements which must be developed or supported with additional support equipment. The natural tendency in the past has been to purchase the vendor's PGSE which runs up the life cycle costs with additional documentation and training and creates specialists which may not be utilized to a full time assignment. The ATE design should lend itself to expansion to cover these situations. On the other hand, an expensive computer operated tester should not be used when a simple volt-ohmmeter and a continuity chart can do the job.

Most ATE consists of a basic computer and peripherals to control and observe the testing of the UUT. The remaining two sections are the ATE interface and the building blocks. The building blocks (BB's) are signal stimulus response monitoring equipment, power supplies and switching which perform the testing that is processed by the computer. These BB's may be standard test equipment or synthesizers such as those contained in a third generation ATE such as the AN/USM-410. In comparing the BB usage against the operational electronics requirements, some BB's are not required and should be eliminated unless the cost of elimination would be prohibitive limit expansion capabilities. Low usage BB's can be built into the

Interface Device (ID) if cost effective, thus keeping the basic ATE costs down.

A solution to added test requirements and future expansion capabilities is the addition of a standard data bus interface to the ATE.

10.1.3 Program Language

The standard program language should be ATLAS. It is an established language which is easily converted to ATE machine code. The ATE should have on-line edit capability to reduce UUT integration costs. Safeguards should be included to insure configuration control of software. The software should allow for the use of Automatic Test Program Generation (ATPG) such as LASAR and/or guided probe. The software should be modular for easy expansion and documentation should be included in the programming manual to assist the TPS engineer in development of new test programs.

10.1.4 ATE Hardware Design

The ATE should be ruggedized, but not MIL standard to reduce costs. Human factors should be a major consideration in the layout for efficient operation of the UUT. The AN/USM-410 has a work surface for the UUT which enhances its utility. The documentation should cross reference software functions and interface pins for quick identification for the operator and the TPS designer.

The ATE interface is the most critical cost item in the selection of test requirements. Some of the elements which impact cost are:

- o Dedicated pins vs. universal switching
- o Performance characteristics vs universal switching

- o Number of pins
- o Interface connector design and reliability
- o LRU vs SRU interface requirements

Dedicated pins to the stimulus and response functions of the ATE generally result in the need for a unique interface device (ID) to route signals to the proper pins for each UUT. If testability was a design consideration in the development of the operational electronics, fewer connector types will be required, resulting in some UUT's sharing the same ID. If the ATE has universal switching so that any function can be connected to any interface pin, multiplexing of UUT's on a single ID will greatly reduce production and maintenance costs. The performance trade-off when using universal switching is caused by distributed capacity and other characteristics which degrade signal performance.

This trade-off is a greater concern in the case of LRU's over the SRU's. Dedicated high speed digital RF signals, UUT power and low level measurement pins will be required in ATE systems with universal switching.

Good testability requirements in the development of electronics will avoid added complexity in the ID's. If signal conditioning is required, the cost of ID design and production costs is increased in the order of one to ten hours per pin. If, for example, a system to be used has low level differential digital logic instead of the standard TTL, many buffers would be required and additional self test circuitry would further increase costs. A standard auxiliary interface device designed to convert the non-standard logic for up to six (6) LRU's and provide control using the standard data bus to the ATE computer would provide a cost-effective design for this situation. This approach would be advisable to increasing the ATE interface requirements for six (6) LRU's or for each new non-standard situation.

The number and design of the ATE interface pins is a major cost item. The number of mating operations may be as high as 5000 per year. A rugged design which is easily repaired is desirable. Wear-out adapters can be considered, but must not degrade interface signal characteristics. When the ATE interface exceeds one hundred pins or has a large number of coaxial pins, the connector costs increase exponentially. This is caused by the need to use a few pins on each interface connector. Large quick disconnect connectors are a viable solution if standard interface auxiliary devices are designed for adapting special cases to the ATE.

The interface requirements for LRU's and SRU's are quite different. LRU requirements in general require higher power, more active digital processing and more modulation techniques. SRU requirements need less power, more loads and matching devices, require a lower pin count. Most ATE utilize an auxiliary interface device to adapt the device for SRU usage. Another approach is to consider augmenting the ATE with table top digital testers to support large quantities of static digital test for SRU's. This alternative must be trade-off with the use of bus controlled specialty testers which can take advantage of the ATE software system's full capability including automatic test program generation (ATPG).

10.2 ATE EXPANDABILITY

Table B shows the predicted expansion in ATE characteristics which will be required in the next five and ten years. Existing ATE will require that the computer interface bus be connected to a standard instrumentation data bus to provide expansion capability for future growth. Three recommended data buses are:

MIL-STD-1397

MIL-STD-1553 or 1553A

IEEE STD 488

With a standard data bus interface, the core ATE can be kept to a minimum with special test requirements and expansion connected via the data bus to the ATE computer. The same standard data bus can be used at the vendor repair level to simulate Depot and GS interface requirements without the use of the basic ATE.

10.3 ATE AVAILABILITY

ATE Availability is computed in the same manner as the UUT:

$$\text{Availability} = \frac{\text{MTBF}}{\text{MTBF} + \text{MTTR}}$$

High reliability is essential. MTTR includes time to detect, isolate and repair the ATE. MTTR becomes more critical if only one ATE is located at the site. MTTR for ATE can be minimized by acquiring test systems with self-check (confidence test) and self-test (diagnostics) capability. Self-check capability of ATE should be implemented by operator command without removal of any elements of the system and should run automatically in less than fifteen minutes. In case of ATE/UUT ambiguities, an interface signal wraparound test, using a shorting plug should be included in the extended self-check test to eliminate the ATE as the source of error. Self-check should identify the BB which has failed and should be keyed to extended testing of the failed BB using self-test.

Self-test should be possible without physically removing units from the ATE system. Those elements of the ATE which will virtually down the system when failures occur should have adequate spare modules to insure a minimum of one hour turnaround in the repair cycle. When practical, environmental specifications for ATE should be relaxed to permit use of commercially available, ruggedized ATE systems.

ATE support equipment should be acquired with the ATE to provide rapid repair capability of ATE modules at the site.

10.4 ATE HUMAN FACTORS

ATE requirements should consider human factors as they impact station operating costs. Some considerations which the design must provide are:

- o Quick setup/tear-down time
- o Optimized man-machine interface for controls, monitors, etc.
- o Easily operated control instructions
- o Efficient work space for the unit under test (UUT)
- o Built-in status monitoring and emergency power shutdown in case of catastrophic faults
- o Standard Mnemonics to reduce operator errors between both software and hardware
- o Quick recall of self-check (confidence) test capability
- o Minimum utilization of self-test (diagnostic test) requirements to remove ATE equipment from the system for fault isolation

10.5 ATE DOCUMENTATION

ATE documentation should be easily interpreted. The performance specifications at the interface should be tabulated for quick reference. Internal performance characteristics may be shown in reference, but should be clearly identified if there is system degradation due to the interface. The most important feature should be a single volume for programming and determining performance characteristics expended when developing test programs. This feature should relate directly to the Test Requirement Documents (TRD's) developed for each UUT.

The quality control provisions of the ATE specification should demonstrate full system performance during the first article testing and adequate sampling of critical tests for subsequent production acceptance tests for all ATE systems.

Application: _____
 Manufacturer: _____
 Self-Test Capability: End-to-End _____
 Run Time: _____
 ATE: _____
 MTR: _____
 Type: _____
 Cost (K): _____
 Computer Model No: _____
 Manufacturer: _____
 Memory Size: _____
 Test Program: _____
 Program Storage Medium: _____
 Magnetic Tape: _____
 Paper Tape: _____
 Other: _____
 Test Language: _____
 On-Line Test: _____
 Interface: _____
 Quantity: _____
 Measurement: _____
 X-10: _____
 Type: _____
 Cathode: _____
 Anode: _____
 Power: _____

FIGURE 10.1

ATE CHECKLIST

Manufacturer _____

Nomenclature _____

Self-Test Capability - End-To-End _____ Diagnostic _____

Run Time _____

MTBF _____ MTTR _____

| | | | | |
|------|---------|--------|--------|------------------|
| Type | Digital | Analog | Hybrid | Cost (K\$) _____ |
| | | | | |

Computer Model No. _____ Manufacturer _____

Memory Size _____

Compiler _____

Test Program _____

Program Storage Medium _____

Magnetic Tape _____ Paper Tape _____ Disk _____ Card _____

Other _____

Test Language _____

On-Line Edit _____

Interface _____

| Type | Quantity |
|-----------|----------------------------------|
| Dedicated | Stimulus _____ Measurement _____ |
| Universal | _____ |
| Power | _____ X-10 |

ATE CHECKLIST (Cont'd.)

Power Supplies

| No. | Voltage Range | Current | Resolution | Accuracy |
|-----|---------------|---------|------------|----------|
| | | | | |
| | | | | |
| | | | | |
| | | | | |
| | | | | |
| | | | | |
| | | | | |

Stimulus Sources

| Type | Quantity | Range | Resolution | Accuracy |
|------|----------|-------|------------|----------|
| | | | | |
| | | | | |
| | | | | |
| | | | | |
| | | | | |
| | | | | |

Measurement Capability

| Type | Range | Resolution | Accuracy |
|------|-------|------------|----------|
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |

TABLE A
FIGURE 10.2
AN/USM-410 (V) PERFORMANCE

STIMULUS

| | |
|----------------------|--|
| DC-Signal | 2 ea 0 to \pm 60V @ 4A |
| | 1 ea 0 to \pm 28V @ 5A |
| | 2 ea 0 to \pm 36V @ 9A |
| | 1 ea 0 to \pm 36V @ 25A |
| | 1 ea 0 to \pm 500V @ 0.4A |
| | 1 ea 0 to \pm 1000V @ 0.2A |
| | |
| DC-Standard | 0-111.111VDC \pm 0.001V \pm 0.003%/6 mo |
| AC-Power | 0-130VRMS, 50VA 1 or 3 phase 45-10KHZ |
| AC-Signal | 20 VP-P into 50 OHM |
| | Sinewave .015 to 6 MHZ |
| | Squarewave .015 to 3 MHZ |
| | Trianglewave .015 to 3 MHZ |
| | Sawtooth .015 to 3 MHZ |
| | Complexwave .015 to 3 MHZ |
| Dual Pulse Generator | 50 NS to 655.36 SEC |
| | 0 - 20 VP-P into 50 OHMS |
| | Rise/Fall 25 NS to 0.5 SEC |
| Synchro | 3 Wire to 11.8 V RMS L-L @ 400 HZ |
| | 0-360 DEC 0.02 Steps |
| RF Source | 60 KHZ - 500 MHZ |
| Digital | 32 Bit Parallel Word Gen/Rec |

TABLE A (Cont'd)

MEASUREMENT

| | |
|---------------------------------|---|
| DC Voltage and Ratio | 100 UV to 200 VDC, 0.1% |
| AC RMS Voltage and Ratio | 0 - 140 V RMS, 0.5% - 4% |
| AC Peak Voltage | 0 - 200 VP, 0.5% - 4% |
| Waveform Analysis | DC - 300 MHZ, $\pm 4\%$ |
| Frequency | DC - 500 MHZ |
| Period | 100 NS to 200 SEC |
| Time Interval (Dual Channel) | 20 NS to 2000 SEC |
| Rise or Fall Time & Pulse Width | 20 NS to 2000 SEC |
| Phase Angle | 0.2 HZ to 10 MHZ, $\pm 180^\circ$ |
| Synchro Angle | 0 - 360° , 0.2° |
| Impedance | 10 OHM to 100 K MEGOHM, $\pm 4\%$ |
| Transfer Function | 0 - 175 V RMS, DC - 20 MHZ, 0 - 360° |
| Harmonic Distortion | 50 MV to 140 V RMS, $\pm 3\%$ |
| Harmonic Analysis | 2 HZ - 300 MHZ, - 40 DB, ± 0.8 DB |

TABLE A (Cont'd)

INTERFACE

Dedicated Pins Stimulus and Responses (DIU)

Two Coax Relays

32 Switches

Programmable Interface (PIU)

128 Input/Output Pins

128 Measurement Only Pins

2 Probes

RF SUBSYSTEM

Stimulus

60 KHZ to 500 MHZ - 117 to + 10 DBM

500 MHZ to 18 GHZ - 105 to + 5 DBM

AM and Pulse Modulation

Measurement

Power 10 MHZ to 18 GHZ - 35 DBM to + 30 DBM

Frequency 10 HZ to 18 GHZ

Spectrum Analysis 10 MHZ to 18 GHZ

AM & FM Demodulation

Complex Impedance 110 MHZ to 18 GHZ

VSWR or Reflection Coefficient

Signal Processing

Attenuation 0 to 127 DB DC to 1 GHZ

0 to 110 DB DC to 18 GHZ

Delay 10 NS to 10 MICROSEC

TABLE B

FIGURE 10.3

FUTURE ATE REQUIREMENTS

| PARAMETER | 5 Years | 10 Years |
|------------------------|-----------------------|----------------------------|
| FREQUENCY | 40 GHZ | 100 GHZ |
| FREQ HOPPING | 20 - 10 K HOPS/SEC | 20 - 10 K HOPS/SEC |
| DIGITAL LOGIC | 100 MBPS | 1 GBPS |
| DISTRIBUTED PROCESSING | MSI | LSI |
| OPTICAL/IR | 30 MBPS | 100 MBPS |
| SEISMIC | --- | 0.1 - 1000HZ 0.1 - 100g |

SECTION XI

11.0 CONFIGURATION MANAGEMENT

11.1 CAPABILITIES

The Configuration Management System required for test programs requires the classic techniques of identification, control and accounting. This system defines the procedures, forms and data elements necessary to provide the foundation upon which effective configuration control is based. The system delineates the overall requirements and provides a unified approach to configuration management. The "system" not only satisfies the requirements of contractual obligations, but provides for any need of large-scale system-type programs and further ensures a total support point of view.

11.2 ORGANIZATION

The direction and coordination of the effort described in this section is the responsibility of the Configuration Manager, under the functional direction of the Program Manager. The tasks required to comply with this procedure will be accomplished within the existing Project Organization structure by the Configuration Manager. The various functions such as Engineering, Manufacturing, Material, Support Services, and Quality Assurance are coordinated by the Configuration Manager to assure compliance.

11.3 ENGINEERING CHANGE CONTROL

There must be established a formal Configuration Control Board to maintain, control and evaluate changes to contractual technical requirements; released design, quality assurance, maintenance; and hardware to assure that such changes are authorized and actually incorporated in any hardware developed, i.e., Interface Devices, reflected in all affected data, and compliant with requirements. The Configuration Control Board is operated on a continuation basis during the development phase of the program.

11.4 DRAWINGS

Engineering Drawings required for the test program adapters should be prepared in accordance with the requirements of MIL-D-1000, MIL-D-100, Form 3.

11.5 SPECIFICATION AND ENGINEERING DATA RELEASE

Engineering drawings, specifications and standards used to define the configuration of each article should be released for the purpose of formally establishing an approved engineering document. The "release" is indicated by the data control release signature and date appearing on the reproduced documents.

11.6 CONFIGURATION MANAGEMENT OF SOFTWARE

For purposes of configuration management, computer software programs are defined as a punched or magnetic deck of cards, tapes or other physical medium containing a sequence of instructions. Punched or magnetic card decks and computer tapes for deliverable computer programs are delivered, accepted and managed as a Configuration Item product.

11.7 SOFTWARE PROGRAM IDENTIFICATION

Identification of Computer Software Programs is as follows:

- a. The band or case of each deck should be marked with the part number of the deck and the design activity code identification number.
- b. The outside end of each computer tape should be marked or punched for direct visual interpretation of its complete item identification and part number and design activity code identification number. The same information should appear on the tape's reel and/or cannister.

11.8 COMPUTER PROGRAM CONTROL

The aspects of the computer program which are subject to configuration management are:

- a. The physical form dimensions, and materials of the tape or card deck medium.
- b. The actual sequence and content of the instructions and data.

11.9 ENGINEERING SOFTWARE CHANGE PROCESSING

Changes to computer programs are processed for approval in the same manner as changes to drawings or hardware.

11.10 SOFTWARE DOCUMENTATION

Identification of Software Documentation - The following guidelines should be used to identify and aid in control of all items:

- a. Perforated Tape - The outside end of each tape should be punched with part number and revision letter such that direct visual identification is readily obtained.
- b. Card Decks - Boxes of cards should be clearly marked with proper part number and revision letter. Cards within a box should be numerically sequenced so that incomplete decks can be detected.
- c. Listings - Each page of the listing should be marked as to proper part number and revision letter. Pages should be numerically sequenced so that incomplete listings can be detected.
- d. Program Flow Diagrams - Flow diagrams and user handbooks should be maintained in the same manner as a hardware configuration drawing. The documents should contain part numbers and proper revision letter and further contain cross reference to applicable computer program configurations.